

### **General Description**

The MAXQ7665A-MAXQ7665D smart systems-on-a-chip (SoC) are data-acquisition systems based on a microcontroller (µC). As members of the MAXQ® family of 16bit, reduced instruction set computing (RISC) µCs, the MAXQ7665A-MAXQ7665D are ideal for low-cost, lowpower, embedded applications such as automotive, industrial controls, and building automation. The flexible, modular architecture design used in these µCs allows development of targeted products for specific applications with minimal effort.

The MAXQ7665A-MAXQ7665D incorporate a high-performance 16-bit RISC core, a 12-bit 500ksps SAR ADC with a programmable gain amplifier (PGA), and a full CAN 2.0B controller supporting transfer rates up to 1Mbps. These devices include a 12-bit DAC with a buffered voltage output and on-chip oscillator circuitry to operate from an external high frequency (8MHz) crystal. There is also a built-in internal RC oscillator as an alternative to using an external crystal. The MAXQ7665A-MAXQ7665D contain an internal temperature sensor to measure die temperature and a remote temperature-sensor driver. The analog functions and digital I/O are powered from a +5V supply, while the internal digital core is powered from +3.3V, which can be supplied by an on-chip linear regulator. These devices also include a dual power-supply supervisor with reset and a JTAG interface for in-system programming and debugging. The 16-bit RISC µC includes up to 128KB (64K x 16) of flash memory and 512 bytes (256 x 16) of RAM.

The MAXQ7665A-MAXQ7665D are available in a 7mm x 7mm 48-pin TQFN package and are specified to operate from  $-40^{\circ}$ C to  $+125^{\circ}$ C.

### **Applications**

Automotive Steering Sensors CAN- and LIN-Based Automotive Sensors Industrial Control

#### **Features**

#### ♦ High-Performance, Low-Power, 16-Bit RISC Core

DC-to-8MHz Operation, Approaching 1MIPS per MHz Low Power (< 3mA/MIPS, DVDD = +3.3V) 16-Bit Instruction Word, 16-Bit Data Bus 33 Instructions (Most Require Only One Clock Cycle) 16-Level Hardware Stack

Three Independent Data Pointers with Automatic Increment/Decrement

#### ♦ Program and Data Memory

Up to 128KB (64K x 16) Internal Flash 512 Bytes (256 x 16) Internal RAM

#### **♦ Smart Analog Peripherals**

Low-Power, Eight Differential-Channel, 12-Bit, 500ksps ADC

Programmable-Gain Amplifier, Software-Selectable Gain: 1V/V, 2V/V, 4V/V, 8V/V, 16V/V, 32V/V 12-Bit DAC with Buffered Voltage Output External References for ADC and DAC Internal (Die) and External Diode Temperature Sensing

#### **♦ Timer/Digital I/O Peripherals**

Full CAN 2.0B Controller

15 Message Centers (256-Byte Dual Port Memory) Programmable Bit Rates from 10kbps to 1Mbps Standard 11-Bit or Extended 29-Bit Identification

Two Data Masks and Associated IDs for DeviceNET™, SDS and Other Higher Layer CAN Protocols External Transmit Disable for Autobaud SIESTA Low-Power Mode Wake-Up on CANRXD Edge Transition

UART (LIN) with User-Programmable Baud Rate 16 x 16 Hardware Multiplier with 48-Bit Accumulator, Single Clock Cycle Operation

Three 16-Bit (or Six 8-Bit) Programmable Timer/Counter/PWM

Eight General-Purpose, Digital I/O Pins, with External Interrupt Capability

All Interrupts Can Be Used as a Wake-Up

### ♦ Crystal/Clock Module

Internal Oscillator for Use with External Crystal On-Chip RC Oscillator Eliminates External Crystal External Clock-Source Operation Programmable Watchdog Timer

#### **♦ Power-Management Module**

Power-On Reset (POR)

Power-Supply Supervisor/Brownout Detection for Digital I/O and Digital Core Supplies On-Chip +3.3V, 50mA Linear Regulator

#### **♦ JTAG Interface**

Extensive Debug and Emulation Support In-System Test Capability Flash-Memory-Program Download Software Bootstrap Loader for Flash Programming

### ♦ Ultra-Low-Power Consumption

Low-Power, Divide-by-256 PMM Mode Stop Mode

Ordering Information/Selector Guide and Pin Configuration appear at end of data sheet.

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For pricing delivery, and ordering information please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

#### **ABSOLUTE MAXIMUM RATINGS**

| DV <sub>DD</sub> to DGND, AGND, or GNDIO0.3V to +4V   |
|---|
| DGND to GNDIO or AGND0.3V to +0.3V                    |
| DV <sub>DDIO</sub> to DGND, AGND, or GNDIO0.3V to +6V |
| AV <sub>DD</sub> to DGND, AGND, or GNDIO0.3V to +6V   |
| Digital Inputs/Outputs to DGND, AGND, or GNDIO        |
| 0.3V to (DV <sub>DDIO</sub> + 0.3V)                   |
| Analog Inputs/Outputs to DGND, AGND, or GNDIO         |
| -0.3V to (AV <sub>DD</sub> + 0.3V)                    |
| RESET XIN XOLIT to DGND, AGND, or GNDIO               |

.....-0.3V to (DV<sub>DD</sub> + 0.3V)

| Continuous Current into Any Pin                | ±50mA          |
|--|----------------|
| Continuous Power Dissipation ( $T_A = +70$ °C) |                |
| 48-Pin TQFN (derate 40mW/°C above +70°C        | C)3200mW       |
| Operating Temperature Range                    | 40°C to +125°C |
| Junction Temperature                           | +150°C         |
| Storage Temperature Range                      |                |
| Lead Temperature (soldering, 10s)              | +300°C         |
|  |                |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{SYSCLK} = 8MHz, V_{REFDAC} = V_{REFADC} = +5V, T_{A} = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $T_{A} = +25^{\circ}\text{C.}$ ) (Note 1)

| PARAMETER   | SYMBOL             | CONDITIONS  | MIN  | TYP  | MAX  | UNITS |  |
|---|--------------------|---|------|------|------|-------|--|
| POWER REQUIRMENTS   |                    |   |      |      |      | •     |  |
|   | DV                 | Safe mode (RC/2 = 3.8MHz)   | 2.7  | 3.3  | 3.6  |       |  |
| Owner by Welter on Demand   | DV <sub>DD</sub>   | Normal mode   | 3.0  | 3.3  | 3.6  | .,    |  |
| Supply Voltage Range  | AV <sub>DD</sub>   |   | 4.75 | 5.0  | 5.25 | V     |  |
|   | DV <sub>DDIO</sub> |   | 4.75 | 5.0  | 5.25 |       |  |
| AV Cupply Current   | Luces              | Shutdown (Note 2)   |      | 0.1  | 10   | μΑ    |  |
| AV <sub>DD</sub> Supply Current                                   | lavdd              | All analog functions enabled  |      | 6.7  | 8    | mA    |  |
|   |                    | ADC enabled, f <sub>ADC</sub> = 1ksps, f <sub>SYSCLK</sub> = 8MHz   |      | 4.2  |      |       |  |
|   |                    | ADC enabled, f <sub>ADC</sub> = 500ksps, f <sub>SYSCLK</sub> = 8MHz   |      | 1890 |      |       |  |
| Analog Module Subfunction   |                    | DAC enabled (zero scale)  |      | 305  | μΑ   |       |  |
| Incremental Supply Current  |                    | Internal temperature sensor enabled   |      | 502  |      | ]     |  |
|   |                    | Additional current when one or more of the ADC, DAC, and/or temperature sensor is enabled (only counted once) |      | 128  |      |       |  |
|   |                    | PGA enabled   |      | 4.5  |      | mA    |  |
|   |                    | CPU in stop mode, all peripherals disabled  | İ    | 3    | 20   | μΑ    |  |
|   |                    | Medium-speed mode (Note 3)  |      |      | 5    |       |  |
| DV <sub>DD</sub> Supply Current                                   | IDVDD              | High-speed mode (Note 4)  |      |      | 28   | A     |  |
|   |                    | Low-speed mode (Note 5)   |      |      | 2    | mA    |  |
|   |                    | Flash erase or write mode   |      | 35   | 50   |       |  |
| DV M 11 0 17  |                    | DV <sub>DD</sub> supervisor and brownout monitor  |      | 2    |      |       |  |
| DV <sub>DD</sub> Module Subfunction<br>Incremental Supply Current |                    | HF crystal oscillator   |      | 150  |      | μΑ    |  |
| moremental ouppry ourrent   |                    | Internal RC oscillator  |      | 200  |      |       |  |
| DVDDIO Supply Current   | IDVDDIO            | All digital I/Os static at GND or DV <sub>DDIO</sub>  |      |      | 10   | μΑ    |  |
| DADDIO arbbis carrent   | טוטטעטי            | (Note 6)  |      |      | 1000 | μΛ    |  |

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{SYSCLK} = 8MHz, V_{REFDAC} = V_{REFADC} = +5V, T_{A} = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_{A} = +25°C.) (Note 1)$ 

| PARAMETER                               | SYMBOL             | CONDITIONS  | MIN  | TYP  | MAX  | UNITS   |
|---|--------------------|---|------|------|------|---------|
| MEMORY SECTION                          | •                  |   |      |      |      | •       |
|   |                    | MAXQ7665A   |      | 128  |      |         |
| 51. J. M                                |                    | MAXQ7665B   |      | 64   |      | 1       |
| Flash Memory Size                       |                    | MAXQ7665C   |      | 48   |      | KB      |
|   |                    | MAXQ7665D   |      | 32   |      | 1       |
|   |                    | $DV_{DD} = +3V$ , at $+25$ °C   |      | 1    |      | MCycles |
| Flash Erase/Write Endurance             |                    | DV <sub>DD</sub> = +3V, at +85°C  |      | 100  |      | kCycles |
|   |                    | DV <sub>DD</sub> = +3V, at +125°C   |      | 100  |      | kCycles |
| Flash Erase Timing                      |                    | One sector  |      | 0.7  | 15   | S       |
| EL LB TOTAL                             |                    | Single word   |      | 11   | 360  | μs      |
| Flash Program Timing                    |                    | Entire flash  |      | 1.5  | 4.5  | S       |
|   |                    | $T_A = +125$ °C, single write   | 20   |      |      |         |
| Flash Data Retention Time               |                    | First 100,000 cycles at +25°C, then retention tested at T <sub>A</sub> = +125°C | 10   |      |      | Years   |
| RAM Memory Size                         |                    |   |      | 512  |      | Bytes   |
| Utility ROM Size                        |                    |   |      | 4096 |      | Words   |
| ANALOG SENSE PATH                       |                    |   |      |      |      | ч       |
| Resolution                              | Nadc               | No missing codes  | 12   |      |      | Bits    |
|   |                    | Gain = 1, bipolar mode, V <sub>IN</sub> = ±2500mV, 500ksps                      |      | ±0.5 | ±4.0 |         |
|   |                    | Gain = 8, unipolar mode, V <sub>IN</sub> = +400mV, 142ksps                      |      | ±2.0 |      |         |
| Integral Nonlinearity                   | INLADC             | Gain = 16, bipolar mode, V <sub>IN</sub> = ±156mV, 142ksps                      |      | ±2.0 | ±4.0 | LSB     |
|   |                    | Gain = 32, bipolar mode, V <sub>IN</sub> = ±50mV, 142ksps                       |      | ±2.0 |      |         |
|   |                    | Gain = 1, bipolar, $V_{IN} = \pm 2500$ mV, 500ksps                              |      |      | ±1.0 |         |
| Differential Nonlinearity               | DNL <sub>ADC</sub> | Gain = 16, bipolar, V <sub>IN</sub> = ±156mV, 142ksps                           |      |      | ±1.0 | LSB     |
|   |                    | All other gain settings   |      | ±0.6 |      |         |
| Offset Error                            |                    | Input referred  |      | ±2.5 | ±5   | mV      |
| Offset-Error Temperature<br>Coefficient |                    |   |      | ±8   |      | μV/°C   |
| Zero-Code Error                         |                    | Bipolar, differential measurement of error for ideal ADC output of 0x000        |      | ±2.5 |      | mV      |
| Gain Error                              |                    | Exclude offset and reference error  | -1.0 |      | +1.0 | %       |
| Gain-Error Temperature<br>Coefficient   |                    |   |      | ±8.5 |      | ppm/°C  |
| Signal-to-Noise Plus Distortion         | SINAD              | PGA gain = 1V/V   |      | -71  |      | dB      |
| Total Harmonic Distortion               | THD                | PGA gain = 1V/V   |      | -85  |      | dB      |



### **ELECTRICAL CHARACTERISTICS (continued)**

 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{SYSCLK} = 8MHz, V_{REFDAC} = V_{REFADC} = +5V, T_{A} = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $T_{A} = +25^{\circ}C.)$  (Note 1)

| Spurious-Free Dynamic Range Conversion Clock Frequency Sample Rate | SFDR               | PGA gain = 1V/V                               |                            |                             |                             |                   |
|--|--------------------|---|----------------------------|-----------------------------|-----------------------------|-------------------|
|  | ,                  | r ua yair = TV/V                              |                            |                             | -91                         | dB                |
| Sample Rate  | fadcclk            | fsysclk = 8MHz                                |                            | 0.5                         | 8.0                         | MHz               |
| Sample Bate  |                    | PGA gain = 1V/V, R <sub>SOUR</sub>            | CE ≤ 1kΩ                   |                             | 500                         |                   |
| Sample Hate  | fSAMPLE            | Any PGA gain setting > 1 $5k\Omega$           |                            |                             | 142                         | ksps              |
| Conversion Time  | tconv              | t <sub>ACQ</sub> plus 13 ADCCLK cy            | cles at 8MHz               |                             | t <sub>ACQ</sub> +<br>1.625 | μs                |
| Channel/Gain Select Plus   |                    | PGA gain = 1V/V, Rsouri                       | CE ≤ 1kΩ                   |                             | 2                           |                   |
| Conversion Time  |                    | Any PGA gain setting, Rs                      | OURCE ≤ 5kΩ                |                             | 7                           | μs                |
|  |                    | PGA gain = 1V/V, Rsoure                       | CE≤1kΩ                     |                             | 375                         | ns                |
| Track-and-Hold Acquisition Time                                    | tACQ               | Any PGA gain setting > 1 $5k\Omega$           | V/V, R <sub>SOURCE</sub> ≤ |                             | 5                           | μs                |
| Turn-On Time   | <sup>t</sup> RECOV |   |                            |                             | 5                           | μs                |
| Aperture Delay   |                    |   |                            |                             | 30                          | ns                |
| Aperture Jitter  |                    |   |                            |                             | 50                          | ps <sub>P-P</sub> |
|  |                    |   | PGA gain = 1               | 0                           | AV <sub>DD</sub>            |                   |
|  |                    |   | PGA gain = 2               | 0                           | 1.6                         |                   |
|  |                    |   | PGA gain = 4               | 0                           | 0.8                         |                   |
|  |                    | Unipolar mode                                 | PGA gain = 8               | 0                           | 0.4                         |                   |
|  |                    |   | PGA gain = 16              | 0                           | 0.2                         |                   |
|  |                    |   | PGA gain = 32              | 0                           | 0.1                         |                   |
|  |                    | Bipolar mode, AIN+ to                         | PGA gain = 1               | -VREFADC /2                 | +VREFADC<br>/2              |                   |
| Input-Voltage Range  |                    |   | PGA gain = 2               | -VREFADC<br>/4              | +VREFADC<br>/4              | V                 |
|  |                    |   | PGA gain = 4               | -V <sub>REFADC</sub><br>/8  | +V <sub>REFADC</sub><br>/8  |                   |
|  |                    | AIN-  | PGA gain = 8               | -VREFADC<br>/16             | +VREFADC<br>/16             |                   |
|  |                    |   | PGA gain = 16              | -VREFADC<br>/32             | +VREFADC<br>/32             |                   |
|  |                    |   | PGA gain = 32              | -V <sub>REFADC</sub><br>/64 | +V <sub>REFADC</sub><br>/64 |                   |
| Absolute Input-Voltage Range                                       |                    |   |                            | AGND                        | $AV_{DD}$                   | V                 |
| Input Leakage Current  | _                  | AIN15-AIN0                                    |                            |                             | ±20                         | nA                |
|  |                    |   | PGA gain = 1               |                             | 180                         |                   |
|  |                    |   | PGA gain = 2               | 140                         |                             | MHz               |
|  |                    |   | PGA gain = 4               | 120                         |                             |                   |
| Small-Signal Bandwidth (-3dB)                                      |                    | V <sub>IN</sub> x gain = 100mV <sub>P-P</sub> | PGA gain = 8               |                             |                             |                   |
|  |                    |   | PGA gain = 16              |                             |                             |                   |
|  |                    |   | PGA gain = 32              |                             | 82                          |                   |

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{SYSCLK} = 8MHz, V_{REFDAC} = V_{REFADC} = +5V, T_{A} = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_{A} = +25$ °C.) (Note 1)

| PARAMETER                               | SYMBOL                                    | CONDITIO   | ONS                          | MIN | TYP  | MAX     | UNITS            |
|---|---|--|------------------------------|-----|------|---------|------------------|
|   |   |  | PGA gain = 1                 |     | 180  |         |                  |
|   |   |  | PGA gain = 2                 |     | 140  |         |                  |
| Large Cianal Dandwidth (2dD)            |   | \\   | PGA gain = 4                 |     | 120  |         | Id I=            |
| Large-Signal Bandwidth (-3dB)           |   | $V_{IN} \times gain = 3.2V_{P-P}$                          | PGA gain = 8                 |     | 100  |         | kHz              |
|   |   |  | PGA gain = 16                |     | 82   |         |                  |
|   |   |  | PGA gain = 32                |     | 80   |         |                  |
|   |   |  | PGA gain = 1                 |     | 13.6 |         |                  |
|   |   |  | PGA gain = 2                 |     | 2    |         |                  |
| Innut Conscitons                        |   | Single-ended, any input                                    | PGA gain = 4                 |     | 4    |         | F                |
| Input Capacitance                       |   | of AIN0 to AIN15   | PGA gain = 8                 |     | 8    |         | рF               |
|   |   |  | PGA gain = 16                |     | 16   |         |                  |
|   |   |  | PGA gain = 32                |     | 32   |         |                  |
| Crosstalk Between Channels              | VcT                                       | AIN15-AIN0, $V_{IN} = 1V_{P-P}$<br>= $5k\Omega$            | , 10kHz, R <sub>SOURCE</sub> |     | -80  |         | dB               |
| Input Common-Mode Rejection<br>Ratio    | CMRR                                      | AIN15-AIN0 (bipolar, difference of the VCM = 100mV to 4.5V | erential),                   | -70 | -90  |         | dB               |
| Power-Supply Rejection Ratio            | PSRR                                      | $AV_{DD} = +4.75V \text{ to } +5.25V$                      | /                            | 67  | 75   |         | dB               |
| DAC SECTION (DACOUT, RL = 5             | $\mathbf{k}\Omega$ and $\mathbf{C}_{L}$ = | 100pF)   |                              |     |      |         |                  |
| Resolution                              | NDAC                                      | Guaranteed monotonic                                       |                              | 12  |      |         | Bits             |
| Differential Nonlinearity               | DNLDAC                                    | Code 147h to E68h  |                              |     | ±0.4 | ±1      | LSB              |
| Integral Nonlinearity                   | INLDAC                                    | Code 147h to E68h  |                              |     | ±0.5 | ±4      | LSB              |
| Offset Error                            |   | Reference to code 040h                                     |                              |     | ±2.5 | ±30     | mV               |
| Offset-Error Temperature<br>Coefficient |   |  |                              |     | ±5   |         | μV/°C            |
| Gain Error                              |   | Excludes reference error,                                  | tested at E68h               |     | ±3   | ±20     | LSB              |
| Gain-Error Temperature<br>Coefficient   |   | Excludes offset and reference calculated from FSR          | ence drift;                  |     | ±2   |         | ppm of<br>FSR/°C |
| DAC Output Range                        |   | No load  |                              | 0   |      | VREFDAC | V                |
|   |   |  | DAC enabled                  |     | 0.5  |         | Ω                |
| DC Output Impedance                     | Z <sub>OUT</sub>                          | Termination resistance to AGND                             | Power-down mode              |     | 105  |         | kΩ               |
| Output Slew Rate                        |   | 400h to C00h code swing                                    | g, rising or falling         |     | 0.6  |         | V/µs             |
| Output Settling Time                    |   | 147h to E68h code swing LSB (Note 7)                       | , settling to ±0.5           |     | 8    | 15      | μs               |
| Output Short-Circuit Current            |   | Short to AGND  |                              |     | -27  |         | mA               |
| Output Short-Oncult Current             |   | Short to AVDD  |                              |     | 46   |         | IIIA             |



### **ELECTRICAL CHARACTERISTICS (continued)**

 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{SYSCLK} = 8MHz, V_{REFDAC} = V_{REFADC} = +5V, T_{A} = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at <math>T_{A} = +25^{\circ}C$ .) (Note 1)

| PARAMETER  | SYMBOL                   | Co   | ONDITIONS  | MIN  | TYP    | MAX              | UNITS             |
|--|--------------------------|--|--|------|--------|------------------|-------------------|
| DAC Glitch Impulse   |                          | From 7FFh to 800   | h  |      | 12     |                  | nV∙s              |
| DAC Power-On Time  |                          | Excluding referen  | ce, settling to ±0.5 LSB   |      | 14     |                  | μs                |
| Power-Supply Rejection   |                          | AV <sub>DD</sub> step from +   | -4.75V to +5.25V   |      | 62     |                  | μV/V              |
| Output Noise   |                          | $C_L = 200pF$  |  |      | 200    |                  | μV <sub>RMS</sub> |
| EXTERNAL REFERENCE INPUTS  | 3                        |  |  |      |        |                  |                   |
| REFADC Input-Voltage Range   |                          |  |  | 1.0  | 5.0    | AV <sub>DD</sub> | V                 |
| REFDAC Input-Voltage Range   |                          |  |  | 0    | 5.0    | AV <sub>DD</sub> | V                 |
| REFDAC Input Impedance   |                          |  |  |      | 200    |                  | kΩ                |
| REFADC Leakage Current   |                          | ADC disabled   |  |      | 1      |                  | μΑ                |
| TEMPERATURE SENSOR (Remo   | te NPN Tran              | sistor 2N3904)   |  |      |        |                  |                   |
|  |                          |  | T <sub>A</sub> = +25°C   |      | ±1     |                  |                   |
|  |                          | Internal diode   | $T_A = -30^{\circ}\text{C to } +85^{\circ}\text{C}$  |      | ±2     |                  |                   |
|  |                          |  | $T_A = -40^{\circ}\text{C to } + 125^{\circ}\text{C}$  |      | ±5     |                  |                   |
|  |                          |  | $T_A = +25$ °C,<br>$T_{RJ} = +25$ °C   |      | ±2     |                  |                   |
| Temperature Error  |                          | External diode, differential $T_{AJ} = C_{AJ} =$ | $T_A = -30$ °C to $+85$ °C,<br>$T_{RJ} = +25$ °C   |      | ±3     |                  | °C                |
|  |                          |  | $T_A = -40^{\circ}\text{C to } + 125^{\circ}\text{C},$<br>$T_{RJ} = +25^{\circ}\text{C}$                           |      | ±3     |                  |                   |
|  |                          |  | $T_A = -30^{\circ}\text{C to } +85^{\circ}\text{C},$<br>$T_{RJ} = -30^{\circ}\text{C to } +85^{\circ}\text{C}$     |      | ±3     |                  |                   |
|  |                          |  | $T_A = -40^{\circ}\text{C to } + 125^{\circ}\text{C},$<br>$T_{RJ} = -40^{\circ}\text{C to } + 125^{\circ}\text{C}$ |      | ±5     |                  |                   |
| Internal (Die) or External<br>Temperature Measurement Error<br>vs. VREFADC Variation |                          |  |  |      | 0.095  |                  | °C/mV             |
| Fataman Diada Carman Commant   |                          | High level   |  |      | 74.7   |                  | ^                 |
| External Diode Source Current  |                          | Low level  |  |      | 4      |                  | μΑ                |
| External Diode Drive Current Ratio   |                          |  |  |      | 18.7:1 |                  | μΑ/μΑ             |
| Conversion Time  |                          | fADCCLK = fSYSCL internal utility ROM  | K = 8MHz, no interrupts,<br>V tempConv   |      | 70     |                  | μs                |
| Temperature Resolution   |                          | 12-bit ADC   |  |      | 0.125  |                  | °C/LSB            |
| +3.3V LINEAR REGULATOR (CDV  | / <sub>DD</sub> = 4.7µF) |  |  |      |        |                  | •                 |
| DV <sub>DDIO</sub> Input-Voltage Range   |                          |  |  | 4.25 | 5.0    | 5.25             | V                 |
| DV <sub>DD</sub> Output Voltage  |                          | REGEN = GNDIO  |  | 3.0  | 3.4    | 3.6              | V                 |
| DV <sub>DD</sub> Input-Voltage Range   |                          | REGEN = DV <sub>DDIC</sub>   | )  | 3.0  |        | 3.6              | V                 |
| No-Load Quiescent Current  |                          | CPU in sleep mod disabled  | de; all digital peripherals  |      | 15     |                  | μΑ                |
| Output Short-Circuit Current   |                          | Short to DGND  |  |      | 110    |                  | mA                |

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{SYSCLK} = 8MHz, V_{REFDAC} = V_{REFADC} = +5V, T_{A} = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted.}$  Typical values are at  $T_{A} = +25^{\circ}C$ .) (Note 1)

| PARAMETER  | SYMBOL  | CONDITIONS  |                               | MIN  | TYP   | MAX  | UNITS   |
|--|---|---|-------------------------------|------|-------|------|---------|
| SUPPLY VOLTAGE SUPERVISOR  | RS AND BRO  | WNOUT DETECTION   |                               |      |       |      |         |
| DV <sub>DD</sub> Voltage-Supervisor Reset<br>Rising Threshold              |   | Power-on default, DV <sub>DD</sub> (Note 9)   | voltage rising                | 2.70 |       | 2.99 | V       |
| DV VIII O :  |   | DV <sub>DD</sub> voltage falling, firmware selectable,  | VDBR = 00b<br>(default)       | 2.70 |       | 2.99 |         |
| DV <sub>DD</sub> Voltage-Supervisor<br>Brownout Reset Falling Threshold    | V <sub>VDBR</sub>                                   | measured with CPU   | VDBR = 01b                    | 2.77 |       | 3.06 | V       |
| Brownout reset raining Threshold   |   | active at 8MHz  | VDBR = 10b                    | 2.84 |       | 3.13 |         |
|  |   | (Note 10)   | VDBR = 11b                    | 2.91 |       | 3.20 |         |
| Software-Selectable DVDD   |   | DV <sub>DD</sub> voltage falling, firmware selectable,  | VDBI = 00b<br>(default)       | 2.77 |       | 3.06 |         |
| Voltage-Supervisor Brownout  | V <sub>VDBI</sub>                                   | measured with CPU   | VDBI = 01b                    | 2.84 |       | 3.13 | V       |
| Interrupt Falling Threshold  |   | active at 8MHz  | VDBI = 10b                    | 2.91 |       | 3.20 |         |
|  |   | (Note 11)   | VDBI = 11b                    | 2.99 |       | 3.27 |         |
|  |   | DV <sub>DDIO</sub> voltage falling, firmware selectable,  | VIOBI = 00b<br>(default)      | 4.25 |       | 4.74 |         |
| DV <sub>DDIO</sub> Voltage-Supervisor<br>Brownout Interrupt Threshold      | V <sub>VIOBI</sub> measured with CPU active at 8MHz |   | VIOBI = 01b                   | 4.30 |       | 4.79 | V       |
| Brownout interrupt Threshold   |   | VIOBI = 10b   | 4.35                          |      | 4.84  |      |         |
|  |   | (Note 12)   | VIOBI = 11b                   | 4.40 |       | 4.89 |         |
| Voltage-Supervisor Hysteresis  |   | DV <sub>DD</sub> , DV <sub>DDIO</sub>   |                               |      | 1     |      | %       |
| DV <sub>DD</sub> Brownout-Interrupt to<br>Brownout Reset Falling Threshold |   | Voltage difference betw<br>V <sub>VDBR</sub> , time allowing so<br>before reset asserted, V<br>VDBR = 10b | ftware clean-up               | 155  |       |      | mV      |
|  |   | DV <sub>DD</sub>  |                               | 1.0  |       | 3.6  |         |
| Voltage Monitor Range  |   | DV <sub>DDIO</sub>  |                               | 0    |       | 5.25 | V       |
| DV <sub>DD</sub> Ramp-Up Rate  |   | DV <sub>DD</sub> must rise faster th between +2.7V and +3.  |                               | 35   |       |      | mV/ms   |
| RESET Hold Time  |   | After DV <sub>DD</sub> rises above trip threshold   | the V <sub>VDBR</sub> voltage |      | 16    |      | ms      |
| CAN INTERFACE  |   |   |                               |      |       |      |         |
| CAN Baud Rate  |   | CANCLK = 8MHz   |                               |      |       | 1    | Mbps    |
| CANCLK Mean Frequency Error  |   | 50ppm external crystal  | error, 8MHz crystal           |      | 60    |      | ppm     |
| CANCLK Total Frequency Error   |   | 50ppm external crystal clock divided and meas interval, mean plus peak                                    | ured over 500µs               |      | < 0.5 |      | %       |
| HIGH-FREQUENCY CRYSTAL OS  | CILLATOR  | •   |                               | -    |       |      | •       |
| Clock Fraguency  |   | Using external crystal  |                               | 1.00 |       | 8.12 | N 41 1- |
| Clock Frequency  |   | External clock source   |                               |      |       | 8.12 | MHz     |
| Crystal Oscillator Startup Time  |   | 8MHz crystal  |                               |      | 10    |      | ms      |
| External Clock Input Duty Cycle  |   | Ratio high-to-low or low-to-high  |                               | 45   |       | 55   | %       |

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{SYSCLK} = 8MHz, V_{REFDAC} = V_{REFADC} = +5V, T_{A} = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_{A} = +25^{\circ}C$ .) (Note 1)

| PARAMETER                        | SYMBOL      | CONDITIONS  | MIN                         | TYP   | MAX                         | UNITS |  |
|----------------------------------|-------------|---|-----------------------------|-------|-----------------------------|-------|--|
| Crystal Oscillator Stability     |             | Excluding crystal   |                             | 3     |                             | ppm/V |  |
|                                  |             | HFIC = 00b (default)  |                             | 7     |                             |       |  |
| VINI Input Lond Conneitones      |             | HFIC = 01b  |                             | 18    |                             | рF    |  |
| XIN Input Load Capacitance       |             | HFIC = 10b  |                             | 27    |                             | PΕ    |  |
|                                  |             | HFIC = 11b  |                             | 34    |                             |       |  |
|                                  |             | HFOC = 00b (default)  |                             | 6     |                             |       |  |
| XOUT Output Load Capacitance     |             | HFOC = 01b  |                             | 17    |                             | nΕ    |  |
| NOOT Output Load Capacitance     |             | HFOC = 10b  |                             | 27    |                             | pF    |  |
|                                  |             | HFOC = 11b  |                             | 34    |                             |       |  |
| XIN Input Low Voltage            |             | Driven with external clock source                               |                             |       | 0.3 x<br>DV <sub>DD</sub>   | V     |  |
| XIN Input High Voltage           |             | Driven with external clock source                               | 0.7 x<br>DV <sub>DD</sub>   |       |                             | V     |  |
| INTERNAL RC OSCILLATOR           |             |   |                             |       |                             |       |  |
| Oscillator Frequency             |             |   | 7.0                         | 7.6   | 8.0                         | MHz   |  |
| Oscillator Startup Time          |             |   |                             | 10    |                             | μs    |  |
| Oscillator Jitter                |             |   |                             | 2.7   |                             | ns    |  |
| UART (LIN) INTERFACE (UTX, U     | RX)         |   |                             |       |                             |       |  |
| UART Baud Rate                   |             |   | 0                           |       | 2                           | Mbps  |  |
| Minimum LIN Mode Operation       |             |   |                             |       | 1                           | kbps  |  |
| Maximum LIN Mode Operation       |             |   | 20                          |       |                             | kbps  |  |
|                                  |             | Crystal clock source  | -0.5                        |       | +0.5                        |       |  |
| UART Baud Rates Error            |             | Using internal RC oscillator before autobaud                    | -14.0                       |       | +14.0                       | %     |  |
|                                  |             | Using internal RC oscillator after autobaud                     | -0.5                        |       | +0.5                        |       |  |
| RESET (RESET)                    |             |   |                             |       |                             |       |  |
| RESET Internal Pullup Resistance |             | Pullup to DV <sub>DD</sub>                                      |                             | 305   |                             | kΩ    |  |
| RESET Output Voltage             |             | High, RESET deasserted, no load                                 | 0.9 x<br>DV <sub>DD</sub>   |       |                             | V     |  |
|                                  |             | Low, RESET asserted, no load                                    |                             |       | 0.4                         |       |  |
| RESET Input High Voltage         |             |   | 0.7 x<br>DV <sub>DD</sub>   |       |                             | V     |  |
| RESET Input Low Voltage          |             |   |                             |       | 0.3 x<br>DV <sub>DD</sub>   | V     |  |
| DIGITAL INPUTS (P0, CANRXD       | , URX, REGE | N)  |                             |       |                             |       |  |
| Input Low Voltage                |             |   |                             |       | 0.3 x<br>DV <sub>DDIO</sub> | V     |  |
| Input High Voltage               |             |   | 0.7 x<br>DV <sub>DDIO</sub> |       |                             | V     |  |
| Input Hysteresis                 |             |   |                             | 500   |                             | mV    |  |
| Input Leakage Current            |             | V <sub>IN</sub> = GNDIO or DV <sub>DDIO</sub> , pullup disabled | -1                          | ±0.01 | +1                          | μΑ    |  |

### **ELECTRICAL CHARACTERISTICS (continued)**

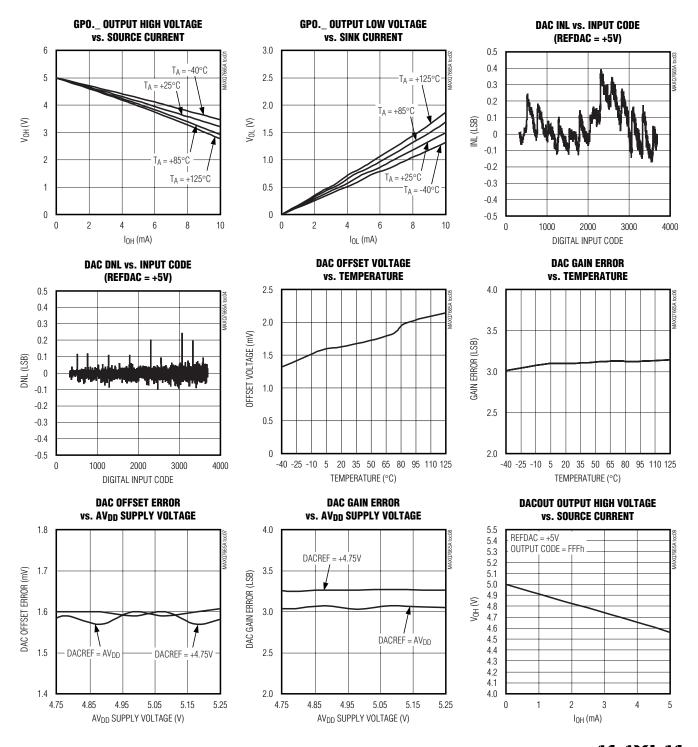
 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{SYSCLK} = 8MHz, V_{REFDAC} = V_{REFADC} = +5V, T_{A} = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted. Typical values are at  $T_{A} = +25$ °C.) (Note 1)

| **                            | , ,        |   |                             |       |     |       |
|-------------------------------|------------|---|-----------------------------|-------|-----|-------|
| PARAMETER                     | SYMBOL     | CONDITIONS                                    | MIN                         | TYP   | MAX | UNITS |
| Input Pullup Resistance       |            | Pullup to DV <sub>DDIO</sub>                  |                             | 400   |     | kΩ    |
| Input Capacitance             |            | V <sub>IN</sub> = GNDIO or DV <sub>DDIO</sub> |                             | 15    |     | рF    |
| DIGITAL OUTPUTS (P0, CAI      | NTXD, UTX) |   |                             |       |     |       |
| Output Low Voltage            |            | ISINK = 1.6mA                                 |                             |       | 0.4 | V     |
| Output High Voltage           |            | ISOURCE = 1.6mA                               | DV <sub>DDIC</sub><br>- 0.5 |       |     | V     |
| Output Leakage Current        |            | I/O pins, three-state                         | -1                          | ±0.01 | +1  | μΑ    |
| Output Capacitance            |            | I/O pins, three-state                         |                             | 15    |     | pF    |
| Outro t Chart Circuit Comment |            | Short to $DV_{DDIO} = +5.25V$                 |                             | 29    |     | m 1   |
| Output Short-Circuit Current  |            | Short to GNDIO                                |                             | 28    |     | mA    |

- **Note 1:** All devices are 100% production tested at  $T_A = +25$ °C.
- Note 2: All analog functions disabled and all digital inputs connected to supply or ground.
- Note 3: Medium-speed mode: CPU and one timer running at 1MHz from an external crystal oscillator, all other peripherals disabled, all digital I/Os static at DV<sub>DDIO</sub> or GNDIO.
- **Note 4:** High-speed mode: CPU and three timers running at 8MHz from an external crystal oscillator, CAN enabled and communicating at 500kbps, all other peripherals disabled, all digital I/Os static at DV<sub>DDIO</sub> or GNDIO.
- Note 5: Low-speed mode: CPU and one timer running from an external crystal oscillator in PMM mode, all other peripherals disabled, all digital I/Os static at DV<sub>DDIO</sub> or GNDIO.
- Note 6: CAN transmitting at 500kbps, one timer output at 500kHz, all active I/Os are loaded with 20pF capacitor, all remaining digital I/Os are at DV<sub>DDIO</sub> or GNDIO.
- Note 7: Guaranteed by design and characterization.
- Note 8: Based on diode ideality factor of 1.008.
- Note 9:  $DV_{DD}$  must rise above  $V_{VDBR}$  for  $\overline{RESET}$  to become deasserted. Caution: Operation is not guaranteed for  $DV_{DD}$  below +2.7V (utility ROM) or +3.0V (flash).
- Note 10: RESET is asserted if DV<sub>DD</sub> falls below V<sub>VDBR</sub>. Caution: Operation is not guaranteed for DV<sub>DD</sub> below +2.7V (utility ROM) or +3.0V (flash).
- Note 11: An interrupt is generated if DV<sub>DD</sub> falls below V<sub>VDBI</sub>. Caution: Operation is not guaranteed for DV<sub>DD</sub> below +2.7V (utility ROM) or +3.0V (flash).
- **Note 12:** An interrupt is generated if DV<sub>DDIO</sub> falls below V<sub>VIOBI</sub>. **Caution:** Operation is not guaranteed if DV<sub>DDIO</sub> or AV<sub>DD</sub> is below 4.75V, except for the DV<sub>DDIO</sub> brownout monitor and +3.3V linear regulator, that still operate down to 0V and +4.25V, respectively.

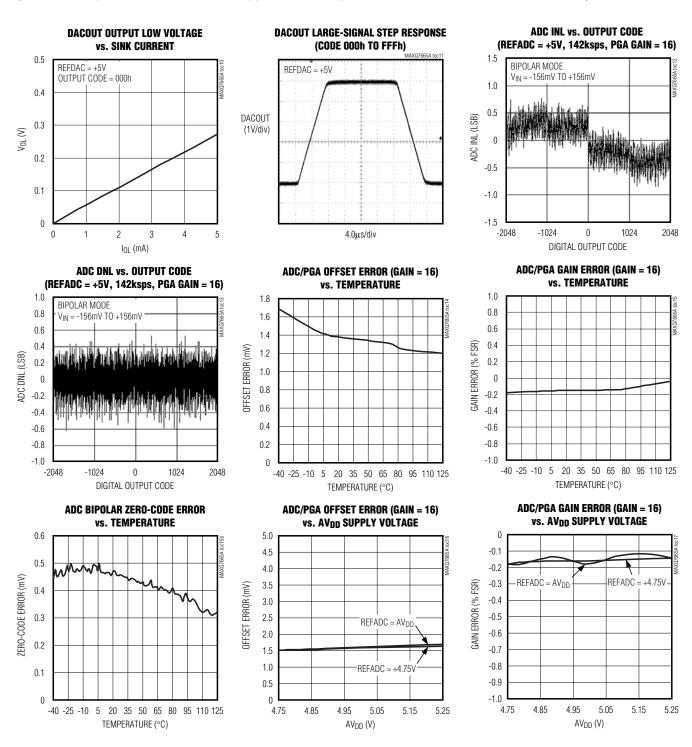
### **Typical Operating Characteristics**

 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{ADCCLK} = 8MHz, f_{ADC} = 500kHz, T_{A} = +25^{\circ}C, unless otherwise noted.)$ 



### Typical Operating Characteristics (continued)

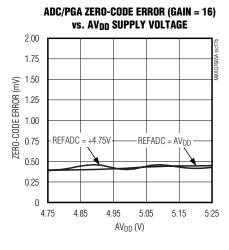
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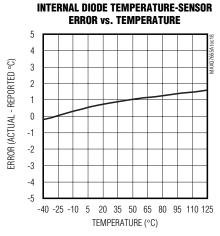


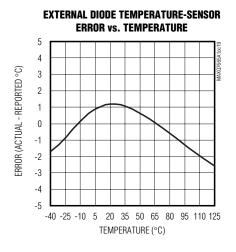
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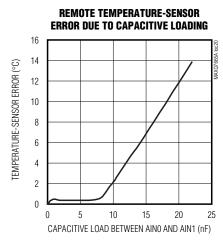
### Typical Operating Characteristics (continued)

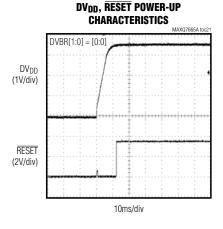
 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{ADCCLK} = 8MHz, f_{ADC} = 500kHz, T_{A} = +25^{\circ}C, unless otherwise noted.)$ 

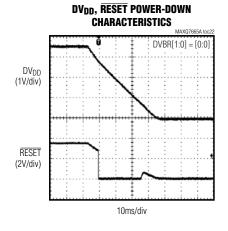


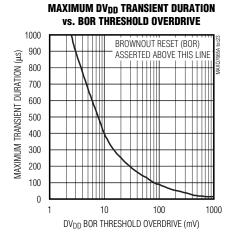


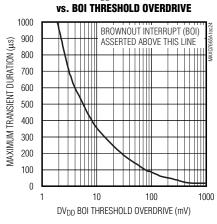




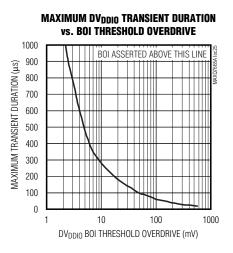








MAXIMUM DVDD TRANSIENT DURATION

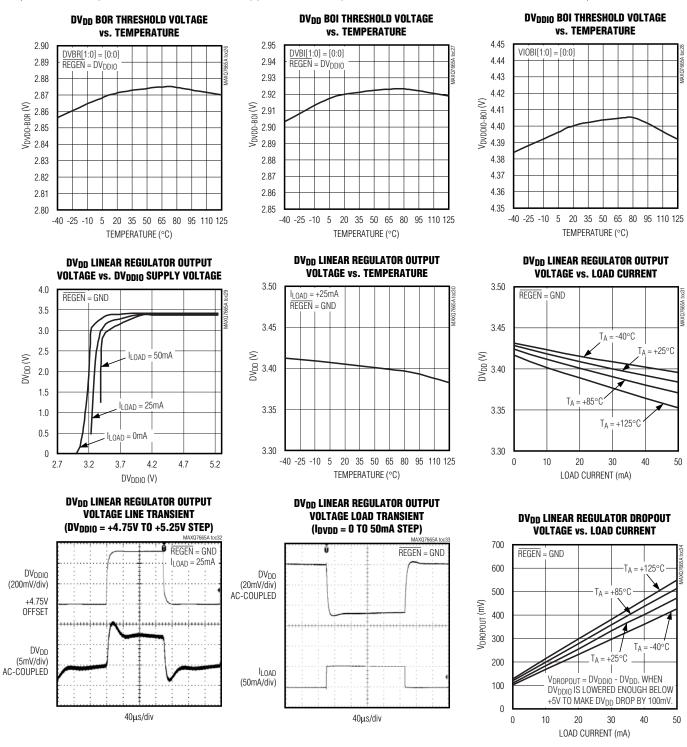


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# 16-Bit RISC Microcontroller-Based Smart Data-Acquisition Systems

### Typical Operating Characteristics (continued)

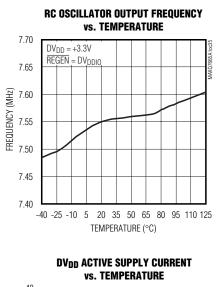
(AVDD = DVDDIO = +5.0V, DVDD = +3.3V, fADCCLK = 8MHz, fADC = 500kHz, TA = +25°C, unless otherwise noted.)

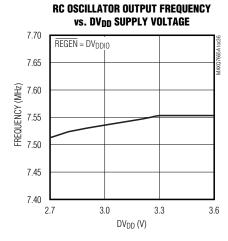


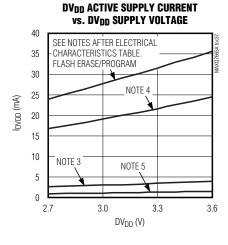
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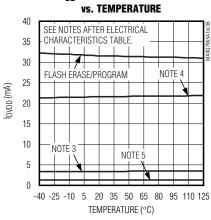
### Typical Operating Characteristics (continued)

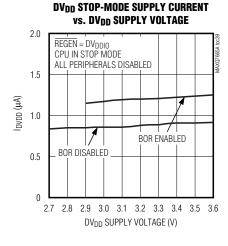
 $(AV_{DD} = DV_{DDIO} = +5.0V, DV_{DD} = +3.3V, f_{ADCCLK} = 8MHz, f_{ADC} = 500kHz, T_{A} = +25^{\circ}C, unless otherwise noted.)$ 

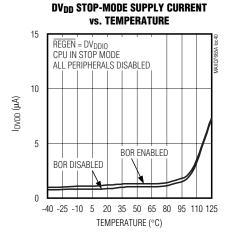


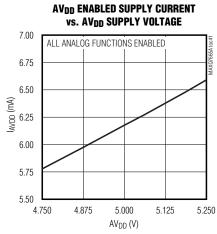


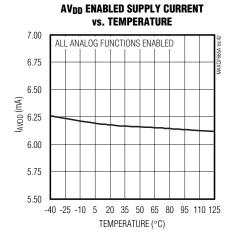


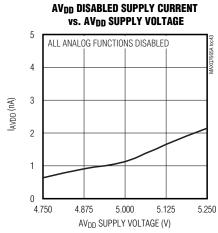








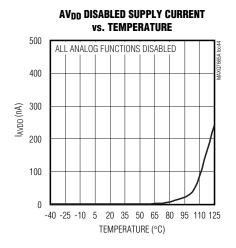


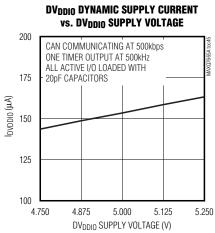


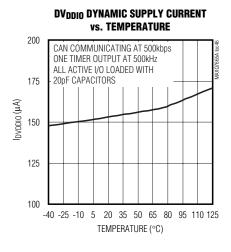
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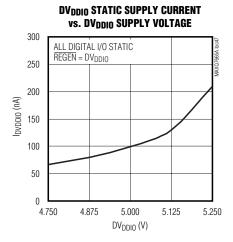
### Typical Operating Characteristics (continued)

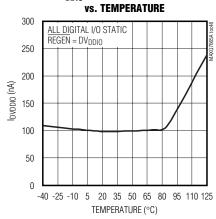
(AVDD = DVDDIO = +5.0V, DVDD = +3.3V, fADCCLK = 8MHz, fADC = 500kHz, TA = +25°C, unless otherwise noted.)



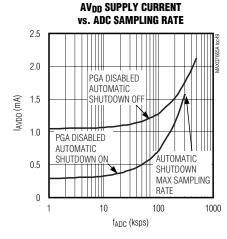


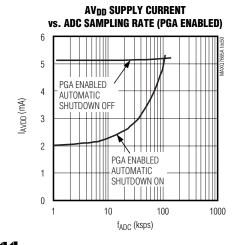


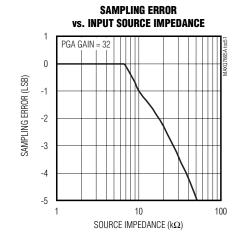




**DVDDIO STATIC SUPPLY CURRENT** 







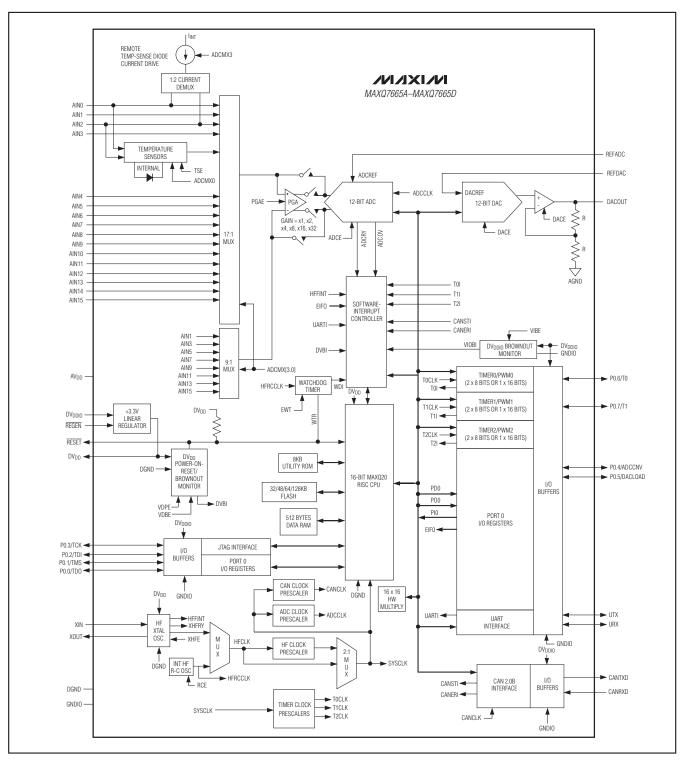
### **Pin Description**

| PIN        | NAME               | FUNCTION  |
|------------|--------------------|---|
| 1          | AIN11              | Analog Input Channel 11. AIN11 is multiplexed to the PGA as a differential input with AIN10.  |
| 2          | AIN10              | Analog Input Channel 10. AIN10 is multiplexed to the PGA as a differential input with AIN11.  |
| 3          | AIN9               | Analog Input Channel 9. AIN9 is multiplexed to the PGA as a differential input with AIN8.   |
| 4          | AIN8               | Analog Input Channel 8. AIN8 is multiplexed to the PGA as a differential input with AIN9.   |
| 5, 8       | AGND               | Analog Ground   |
| 6          | REFADC             | ADC External Reference Input. Connect an external reference voltage between 1V and AV <sub>DD</sub> to REFADC.  |
| 7          | REFDAC             | DAC External Reference Input. Connect an external reference voltage between 0V and AV <sub>DD</sub> to REFDAC.  |
| 9          | AIN7               | Analog Input Channel 7. AIN7 is multiplexed to the PGA as a differential input with AIN6.   |
| 10         | AIN6               | Analog Input Channel 6. AIN6 is multiplexed to the PGA as a differential input with AIN7.   |
| 11         | AIN5               | Analog Input Channel 5. AIN5 is multiplexed to the PGA as a differential input with AIN4.   |
| 12         | AIN4               | Analog Input Channel 4. AIN4 is multiplexed to the PGA as a differential input with AIN5.   |
| 13         | AIN3               | Analog Input Channel 3. AIN3 is multiplexed to the PGA as a differential input with AIN2. AIN3–AIN0 have remote temperature sensor capability.  |
| 14         | AIN2               | Analog Input Channel 2. AIN2 is multiplexed to the PGA as a differential input with AIN3. AIN3–AIN0 have remote temperature sensor capability.  |
| 15         | AIN1               | Analog Input Channel 1. AIN1 is multiplexed to the PGA as a differential input with AIN0. AIN3–AIN0 have remote temperature sensor capability.  |
| 16         | AIN0               | Analog Input Channel 0. AIN0 is multiplexed to the PGA as a differential input with AIN1. AIN3–AIN0 have remote temperature sensor capability.  |
| 17         | DACOUT             | DAC Buffer Output. DACOUT is the DAC voltage buffer output.   |
| 18, 19, 31 | DGND               | Digital Ground for the Digital Core and Flash   |
| 20         | CANRXD             | CAN Bus Receiver Input. Control area network receiver input.  |
| 21         | CANTXD             | CAN Bus Transmitter Output. Control area network transmitter output.  |
| 22         | UTX                | UART Transmitter Output   |
| 23         | URX                | UART Receiver Input   |
| 24         | P0.6/T0            | Port 0 Bit 6/Timer 0. P0.6 is a general-purpose digital I/O with interrupt/wake-up input capability. T0 is a primary timer/PWM input or output.   |
| 25         | P0.7/T1            | Port 0 Bit 7/Timer 1. P0.7 is a general-purpose digital I/O with interrupt/wake-up input capability. T1 is a primary timer/PWM input or output.   |
| 26, 39     | DV <sub>DDIO</sub> | Digital I/O Supply Voltage. Supplies all digital I/O except for XIN, XOUT, and RESET. Bypass DVDDIO to GNDIO with a 0.1µF capacitor placed as close as possible to the device. DVDDIO is also connected to the input of the linear regulator. |
| 27         | GNDIO              | Digital I/O Ground  |
| 28, 29     | I.C.               | Internal Connection. Connect I.C. to GNDIO or DV <sub>DDIO</sub> .  |
| 30         | N.C.               | No Connection. No internal connection. Leave N.C. unconnected.  |
| 32         | P0.0/TDO           | Port 0 Data 0/JTAG Serial Test Data Output. P0.0 is a general-purpose digital I/O with interrupt/wake-up capability. TDO is the JTAG serial test, data output.  |

### Pin Description (continued)

| PIN | NAME             | FUNCTION  |
|-----|------------------|---|
| 33  | P0.1/TMS         | Port 0 Data 1/JTAG Test Mode Select. P0.1 is a general-purpose digital I/O with interrupt/wake-up capability. TMS is the JTAG test mode, select input.  |
| 34  | P0.2/TDI         | Port 0 Data 2/JTAG Serial Test Data Input. P0.2 is a general-purpose digital I/O with interrupt/wake-up capability. TDI is the JTAG serial test, data input.  |
| 35  | P0.3/TCK         | Port 0 Data 3/JTAG Serial Test Clock Input. P0.3 is a general-purpose digital I/O with interrupt/wake-up capability. TCK is the JTAG serial test, clock input.  |
| 36  | P0.4/ADCCNV      | Port 0 Data 4/ADC Start Conversion Control. P0.4 is a general-purpose digital I/O. ADCCNV is firmware configurable for a rising or falling edge start/convert to trigger ADC conversions.   |
| 37  | P0.5/DACLOAD     | Port 0 Data 5/DAC Data Register Load/Update Input. P0.5 is a general-purpose digital I/O with interrupt/wake-up capability. DACLOAD is firmware configurable for a rising or falling edge to update the DACOUT register.  |
| 38  | REGEN            | Active-Low Linear Regulator Enable Input. Connect REGEN to GNDIO to enable the linear regulator. Connect to DV <sub>DDIO</sub> to disable the linear regulator.   |
| 40  | DV <sub>DD</sub> | Digital Supply Voltage. DV <sub>DD</sub> supplies the internal digital core and flash memory. DV <sub>DD</sub> is internally connected to the output of the internal 3.3V linear regulator. Disable the internal regulator to connect DV <sub>DD</sub> to an external supply. When using the on-chip linear regulator, bypass DV <sub>DD</sub> to DGND with a 4.7 $\mu$ F ±20% capacitor with a maximum ESR of 0.5 $\Omega$ . In addition, bypass DV <sub>DD</sub> with a 0.1 $\mu$ F capacitor. Place both bypass capacitors as close as possible to the device. |
| 41  | RESET            | Reset Input and Output. Active-low open-drain input/output with internal $360k\Omega$ pullup to DV <sub>DD</sub> . Drive low to reset the $\mu$ C. RESET is low during power-up reset and during DV <sub>DD</sub> brownout conditions.  |
| 42  | XOUT             | High-Frequency Crystal Output. Connect an external crystal to XIN and XOUT for normal operation. Leave XOUT unconnected if XIN is driven with an external clock source. XOUT is not driven when using the internal RC oscillator.   |
| 43  | XIN              | High-Frequency Crystal Input. Connect an external crystal or resonator to XIN and XOUT for normal operation, or drive XIN with an external clock source. XIN is not driven when using the internal RC oscillator.   |
| 44  | AV <sub>DD</sub> | Analog Supply Voltage Input. Connect $AV_{DD}$ to a +5V supply. Bypass $AV_{DD}$ to AGND with a 0.1 $\mu$ F capacitor placed as close as possible to the device.  |
| 45  | AIN15            | Analog Input Channel 15. AIN15 is multiplexed to the PGA as a differential input with AIN14.  |
| 46  | AIN14            | Analog Input Channel 14. AIN14 is multiplexed to the PGA as a differential input with AIN15.  |
| 47  | AIN13            | Analog Input Channel 13. AIN13 is multiplexed to the PGA as a differential input with AIN12.  |
| 48  | AIN12            | Analog Input Channel 12. AIN12 is multiplexed to the PGA as a differential input with AIN13.  |
|     | EP               | Exposed Pad. EP is internally connected to AGND. Connect EP to AGND externally.   |

### **Block Diagram**



### **Detailed Description**

The  $\mu$ C arithmetic core of the MAXQ7665A–MAXQ7665D is a 16-bit RISC machine with digital and analog peripheral functions. They incorporate a 16-bit RISC ALU with a Harvard memory architecture that can address up to 128KB (64K x 16) of flash and 512 bytes (256 x 16) of RAM memory. They also contain a hardware multiplier, up to eight digital I/Os, a controller area network (CAN 2.0B) bus, a JTAG interface, three timers, an on-chip RC oscillator, a precision 12-bit 500ksps ADC with an 8-channel differential MUX and PGA, a 12-bit precision DAC, an internal temperature sensor and temperature-sensor driver, a linear regulator, watchdog timer, and a dual power-supply supervisor.

The MAXQ offers a low < 3mA/MIPS ratio. The on-chip 16-bit x 16-bit hardware multiplier with accumulator, performs single-cycle computations. Refer to the *MAXQ7665/MAXQ7666 User's Guide* for more detailed information on configuring and programming the MAXQ7665A-MAXQ7665D.

#### **Analog Input Peripheral**

The integrated 12-bit ADC employs an ultra-low-power, high-precision, SAR-based conversion method and can operate up to 500ksps (142ksps with PGA  $\geq$  2). The on-chip 8-channel differential MUX and PGA allow the ADC to measure eight fully differential analog inputs with software-selectable input ranges through the PGA. See Figure 1.

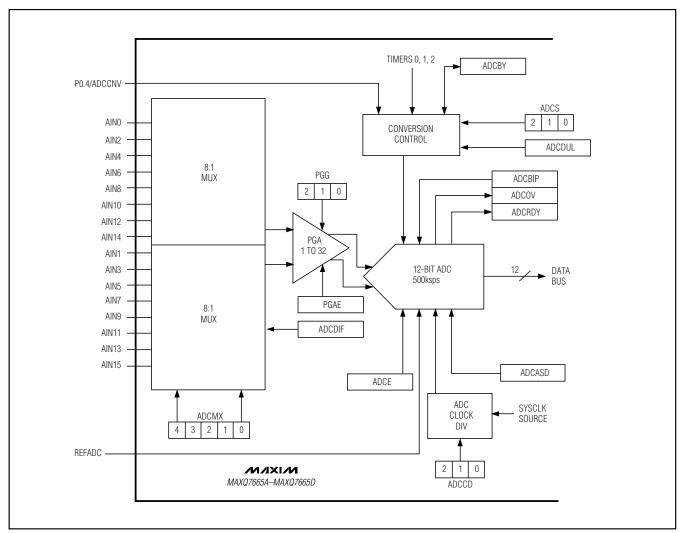


Figure 1. Simplified Analog Input Diagram (Eight Fully Differential Inputs)

The MAXQ7665A–MAXQ7665D ADC uses a fully differential SAR conversion technique and an on-chip T/H block to convert temperature and voltage signals into a 12-bit digital result. Differential configurations are supported using an analog input channel MUX that supports eight differential channels.

The differential analog inputs are selected from the following pairs: AINO/AIN1, AIN2/AIN3, AIN4/AIN5, AIN6/AIN7, AIN8/AIN9, AIN10/AIN11, AIN12/AIN13, and AIN14/AIN15.

Remote temperature-sensor configuration in differential mode uses analog input channel pairs AIN2/AIN3 and AIN0/AIN1. In single-ended remote temperature-sensor configuration, only channels AIN2 and AIN0 are used. Internal temperature-sensor configuration measures local die temperature and does not use any analog input channel.

There are four ways to control the ADC conversion timing:

- 1) Software register bit control
- 2) Continuous conversion
- 3) Internal timers (T0, T1, or T2)
- 4) External input through pin ADCCNV

Refer to the MAXQ7665/MAXQ7666 User's Guide for more detailed information on the ADC and MUX.

#### 12-Bit Digital-to-Analog Converter (DAC)

The MAXQ7665A–MAXQ7665D contain a 12-bit voltage-output DAC with its own output buffer. The data path to the DAC is double buffered and the output register can be updated using the DACLOAD digital input. Refer to the MAXQ7665/MAXQ7666 User's Guide for detailed programming information. The DAC also supports a square-wave-output toggle mode with precise amplitude control for applications that require pulse-amplitude modulation (PAM) and/or pulse-width modulation (PWM) signals. See Figure 2 for a simplified block diagram of the DAC.

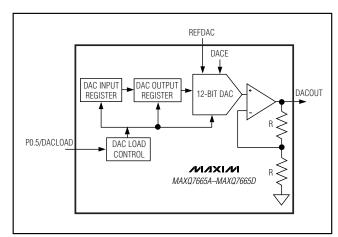


Figure 2. Simplified DAC Diagram

The DAC output buffer is in a voltage follower configuration (gain of 1V/V from REFDAC). The buffer can be disabled when not in use. When the buffer is disabled, the output is connected internally to AGND through a  $100k\Omega$  resistor. The reference input REFDAC accepts an input voltage of less than or equal to AVDD for a maximum output swing of 0V to AVDD.

#### **Temperature Sensor**

The  $\mu$ C measures temperature by using the on-chip ADC and a ROM-based tempConv subroutine. Use the tempConv subroutine to initiate a measurement (refer to the MAXQ7665/MAXQ7666 User's Guide for detailed information). The device supports conversions of two external and one on-chip (internal) temperature sensors. The external temperature sensor is typically a diode-connected small-signal transistor, connected between two analog inputs (differential) or one analog input and AGND (single-ended). Figures 3 and 4 illustrate these two configurations.

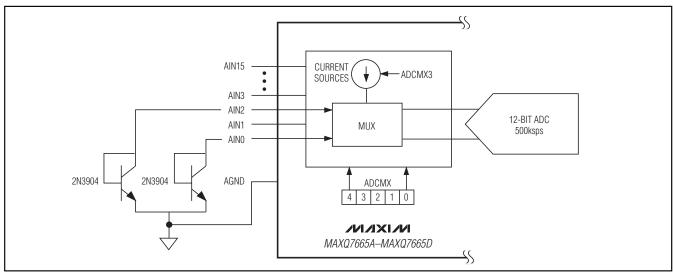


Figure 3. Temperature-Sensor Application Circuit—Single-Ended Configuration

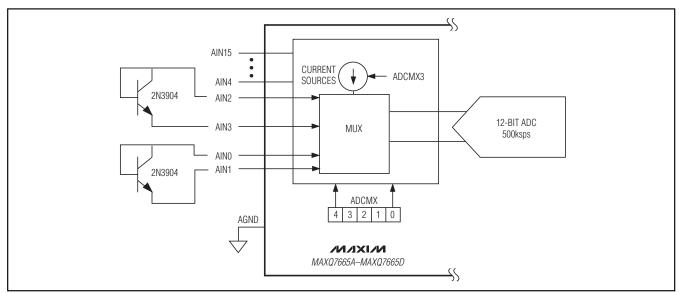


Figure 4. Temperature-Sensor Application Circuit—Differential Configuration

#### Power-On Reset and Brownout

Power supplies DV<sub>DD</sub> and DV<sub>DDIO</sub> each include a brownout monitor that alerts the  $\mu$ C through interrupt when their corresponding supply voltages drop below a selectable threshold. This condition is generally referred to as brownout interrupt (BOI), and these thresholds are set by the VDBI and VIOBI bits for DV<sub>DD</sub> and DV<sub>DDIO</sub>, respectively. Continuous monitoring ensures that a valid supply is present at all times while the  $\mu$ C is executing code. For example, the brownout

monitors check that DV<sub>DDIO</sub> does not drop during a CAN bus transfer, or DV<sub>DD</sub> is not disrupted while the  $\mu$ C core is executing. The DV<sub>DDIO</sub> brownout monitor also covers the analog peripherals if AV<sub>DD</sub> and DV<sub>DDIO</sub> are directly connected.

The DVDD supply (internal core logic) also includes a voltage supervisor that controls the  $\mu C$  reset during power-up (DVDD rising) and brownout (DVDD falling) conditions (see Figure 5 for a POR and brownout timing example).

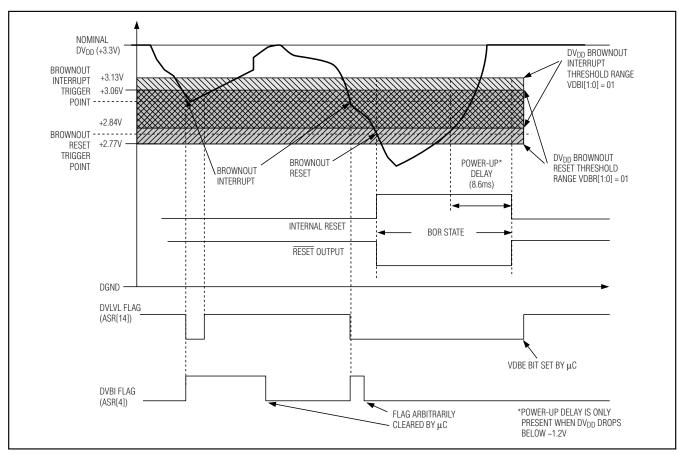


Figure 5. DVDD Brownout Interrupt Detection

During power-up, RESET is held low once DVDD rises above +1.0V. All internal register bits are set to their default, POR state after DVDD exceeds a threshold of approximately +1.2V. This includes the VDBR bits which reset to 00b, resulting in a default, DVDD brownout reset (BOR) threshold in the +2.7V to +2.99V range following POR. Once DVDD rises above this DV<sub>DD</sub> brownout threshold, the 7.6MHz RC oscillator starts driving the power-up counter, and 8.6ms (typ) later, the RESET pin is released and allowed to go high if nothing external is holding it low. An important system-design consideration at power-up is the DVDD ramp-up rate should be at least 35mV/ms between +2.7V and +3.0V. This ensures RESET is not released before DV<sub>DD</sub> reaches a minimum flash operating level of +3.0V. After DVDD has reached a valid level and RESET is released, the µC jumps to the reset vector

(8000h in the utility ROM), and the desired BOI and BOR threshold values can be set by the user through the VIOBI, VDBI, and VDBR bits.

If a valid DV<sub>DD</sub> drops below its BOI threshold (set by the VDBI bits), an interrupt is generated. This offers the possibility of limited software cleanup before the DV<sub>DD</sub> BOR occurs. The amount of cleanup time depends on the VDBI and VDBR brownout threshold bit settings, the size of the DV<sub>DD</sub> bypass capacitors, and the application-dependent, μC power management and software cleanup tasks. Note that if the internal, +3.3V linear regulator is being used to provide DV<sub>DD</sub>, additional software cleanup time is possible by using the DV<sub>DDIO</sub> brownout monitor as an early warning that the regulator's DV<sub>DDIO</sub> (+5V) input voltage is falling, and its DV<sub>DD</sub> (+3.3V) will subsequently drop (unless DV<sub>DDIO</sub> recovers).

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As DV<sub>DD</sub> continues to fall below the DV<sub>DD</sub> BOR threshold set by the VDBR bits, the  $\overline{\text{RESET}}$  pin is pulled low,  $\mu\text{C}$  and peripheral activity stops, and most, but not all of the register bits are set to their default state. This includes the VDBR bits, which retain their value if DV<sub>DD</sub> falls below the BOR threshold, but not below the POR threshold.

Once DV<sub>DD</sub> has entered BOR, there are a few possible scenarios:

- If DV<sub>DD</sub> remains below the BOR threshold, the RESET pin remains low, and the μC remains in the reset state.
- If DV<sub>DD</sub> stops falling before reaching the POR threshold, then begins rising above the BOR threshold, the RESET pin is released, and the μC jumps to the reset vector (8000h in the utility ROM). This is similar to the DV<sub>DD</sub> power-up case described in the previous scenario, except there is no power-up counter delay and some of the register bits are set to BOR values rather than POR values. See Tables 3 and 5 for the reset behavior of specific bits. In particular, the retained VDBR setting, if higher than the default value of 00b, allows a potentially more robust brownout recovery closer to or above the minimum flash operating level of +3.0V.
- If DV<sub>DD</sub> falls below the 1.2V POR threshold, all register bits are reset, and any DV<sub>DD</sub> recovery from that point is identical to the power-up case described above. See Tables 3 and 5 for reset behavior of specific bits.

Refer to the MAXQ7665/MAXQ7666 User's Guide for detailed programming information, and a more thorough description of POR and brownout behavior.

#### Internal 3.3V Linear Regulator

The MAXQ7665A–MAXQ7665D core logic supply, DVDD, can be supplied by a 3.3V external supply or the on-chip 3.3V, 50mA linear regulator. To use the on-chip linear regulator, ensure the DVDDIO supply can support a load of approximately 50mA and connect digital input REGEN to GNDIO. If using an external supply, connect the regulated 3.3V supply to DVDD and connect digital input REGEN to DVDDIO. If the linear regulator is not used, bring up DVDDIO before DVDD.

#### **System Clock Generator**

The MAXQ7665A–MAXQ7665D oscillator module is the master clock generator that supplies the system clock for the  $\mu$ C core and all of the peripheral modules. The high-frequency (HF) oscillator is designed to operate with a 1MHz to 8MHz crystal. Alternatively, the on-chip RC oscillator can be used in applications that do not require precise timing. Due to its RISC design, the

MAXQ7665A–MAXQ7665D execute most instructions in a single SYSCLK period. The oscillator module contains all of the primary clock-generation circuitry. Figure 6 shows a block diagram of the system clock module.

The MAXQ7665A–MAXQ7665D contain many features for generating a master clock signal timing source:

- Internal, fast-starting, 7.6MHz RC oscillator eliminates external crystal
- Internal high-frequency oscillator that can drive an external 1MHz to 8MHz crystal
- External high-frequency clock input (up to 8MHz)
- Selectable internal capacitors for HF crystal oscillator
- Power-up timer
- Power-saving management modes
- Fail-safe modes

#### **Watchdog Timer**

The watchdog timer serves as a time-base generator, an event timer, or a system supervisor. The primary function of the watchdog timer is to supervise software execution, watching for stalled or stuck software. The watchdog timer performs a controlled system restart when the  $\mu P$  fails to write to the watchdog timer register before a selectable timeout interval expires. In some designs, the watchdog timer is also used to implement a real-time operating system (RTOS) in the  $\mu C$ . When used to implement an RTOS, a watchdog timer typically has four objectives:

- 1) To detect if a system is operating normally
- 2) To detect an infinite loop in any of the tasks
- To detect an arbitration deadlock involving two or more tasks
- 4) To detect if some lower priority tasks are not getting to run because of higher priority tasks

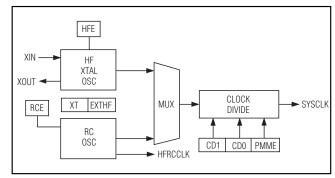


Figure 6. High-Frequency and RC Oscillator Block Diagram

As illustrated in Figure 7, the high-frequency internal RC oscillator (HFRCCLK) drives the watchdog timer through a series of dividers. The divider output is programmable and determines the timeout interval. When enabled, the interrupt flag WDIF is set when a timeout is reached. A system reset then occurs after a time delay (based on the divider ratio).

The watchdog timer functions as the source of both the watchdog interrupt and the watchdog reset. The interrupt timeout has a default divide ratio of 2<sup>12</sup> of the HFR-

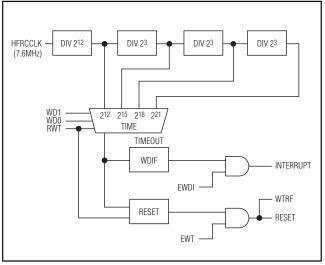


Figure 7. Watchdog Functional Diagram

CCLK, with the watchdog reset set to timeout 29 clock cycles later. With the nominal RC oscillator value of 7.6MHz, an interrupt timeout occurs every 539µs, followed by a watchdog reset 67.4µs later. The watchdog timer is reset to the default divide ratio following any reset. Using the WD0 and WD1 bits in the WDCN register, other divide ratios can be selected for longer watchdog interrupt periods. If the WD[1:0] bits are changed before the watchdog interrupt timeout occurs (i.e. before the watchdog reset counter begins), the watchdog timer count is reset. All watchdog timer reset timeouts follow the programmed interrupt timeout 512 source clock cycles later. For more information on the MAXQ7665A–MAXQ7665D watchdog timer, refer to the MAXQ7665/MAXQ7666 User's Guide.

#### Timer and PWM

The MAXQ7665A–MAXQ7665D include three 16-bit timer channels. Each timer is a type 2 timer implemented in the MAXQ family (see Figure 8). Two of the timers are accessible through I/Os, and one is accessible only through software. Type 2 timers are auto-reload 16-bit timers/counters offering the following functions:

- 8-bit/16-bit timer/counter
- Up/down auto-reload
- Counter function of external pulse
- Capture
- Compare

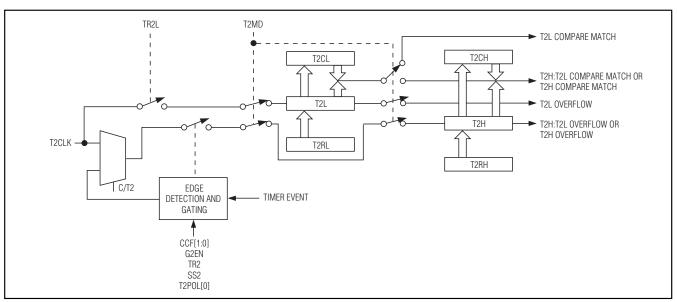


Figure 8. Type 2 Timer Functional Diagram

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**Note:** The MAXQ7665A-MAXQ7665D do not have secondary timer I/O pins (such as T0B and T1B) that are present in some other MAXQ products.

#### 16-Bit x 16-Bit Hardware Multiplier

A hardware multiplier supports high-speed multiplications. The multiplier is capable of completing a 16-bit x 16-bit multiply in a single cycle and contains a 48-bit accumulator that requires one more cycle. The multiplier is not part of the MAXQ core function but a peripheral that performs seven different multiply operations without interfering with the normal core functions:

- Unsigned 16-bit multiplication (one cycle)
- Unsigned 16-bit multiplication and accumulation (two cycles)
- Unsigned 16-bit multiplication and subtraction (two cycles)
- Signed 16-bit multiplication (one cycle)
- Signed 16-bit multiplication and negate (one cycle)
- Signed 16-bit multiplication and accumulation (two cycles)
- Signed 16-bit multiplication and subtraction (two cycles)

Figure 9 illustrates the simplified hardware multiplier circuitry. Two 16-bit parallel-load registers and a 48-bit

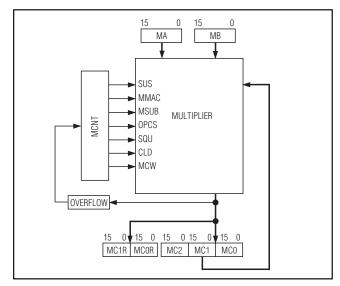


Figure 9. 16-Bit Hardware Multiplier Functional Diagram

accumulator are used: operand A (MA), operand B (MB), and accumulator (MC). The accumulator is formed by three 16-bit parallel registers (MC2, MC1, and MC0). The overflow bit is organized in the MCNT status/control register. The multiplicand and the multiplier are initially loaded into the MA and MB registers, respectively. Loading the required operands triggers the respective multiply, multiply-accumulate/subtract or multiply-negate operation. The multiply operation completes in a single cycle with the results in the read-only MC1R/MCOR register. The multiply-accumulate/subtract operation requires one extra wait cycle for the results to be stable in the MC2, MC1, and MC0 registers.

The main arithmetic unit is the 16-bit x 16-bit multiplier, which processes operands feeding from the MA and MB registers and generates a 32-bit final product. The product value goes through the 32-bit adder to perform final accumulation with zeroes for multiply operation or with the contents from the MC1 and MC0 registers for multiply-accumulation. The final sum is accessible directly from the accumulator.

To support negate operations including signed multiplynegate and signed and unsigned multiply-subtract, the operand in MA is negated by 1's complement operation before being supplied to the arithmetic unit and the partial product terms are sign corrected. Refer to the MAXQ7665/MAXQ7666 User's Guide for more detailed information.

#### **CAN Interface Bus**

The MAXQ7665A-MAXQ7665D incorporate a CAN controller that is fully compliant with the CAN 2.0B specification.

The  $\mu C$  interface to the CAN controller is broken into two groups of registers. To simplify the software associated with the operation of the CAN controllers, most of the global CAN status and controls as well as the individual message center control/status registers are located in the peripheral register map. The remaining registers associated with the data identification, identification masks, format, and data are located in a dual port memory to allow the CAN controller and the processor access to the required functions. The CAN controller can directly access the dual port memory. A dedicated interface is incorporated to support dual port memory accessing by the processor through the CAN 0 data pointer (CODP) and the CAN 0 data buffer (CODB) special function registers.

#### **CAN Functional Description**

The basic functions covered by the CAN controller include the use of 11-bit standard or 29-bit extended acceptance identifiers, as programmed by the  $\mu$ C for each message center, as shown in Figure 10. The CAN unit provides storage for up to 15 messages, with the standard 8-byte data field, in each message.

Each of the first 14 message centers is programmable in either transmit or receive mode. Message center 15 is designed as a receive-only message center with a buffer FIFO arrangement to help prevent the inadvertent loss of data when the  $\mu C$  is busy and is not allowed time to retrieve the incoming message prior to the acceptance of a second message into message center 15. Message center 15 also utilizes an independent set of mask registers and identification registers, which are only applied once an incoming message has not been accepted by any of the first 14 message centers. A second filter test is also supported for all message centers (1–15) to allow the CAN controller to use two separate 8-bit media masks and media arbitration fields to verify the contents of the first 2 bytes of data of

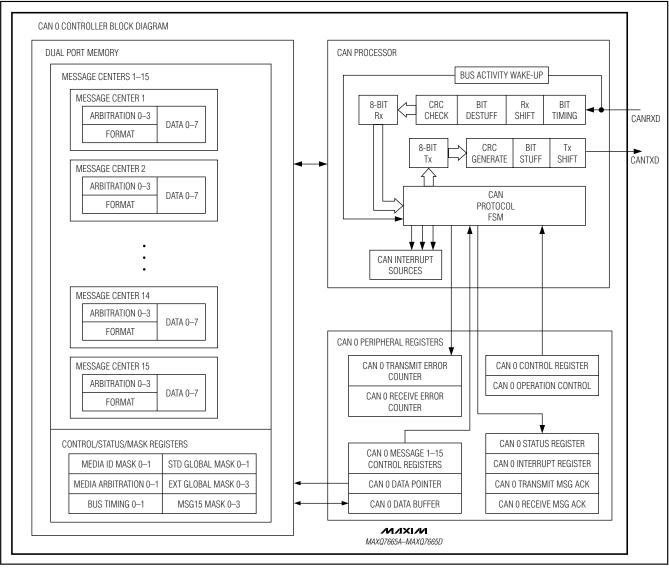


Figure 10. CAN 0 Controller Block Diagram

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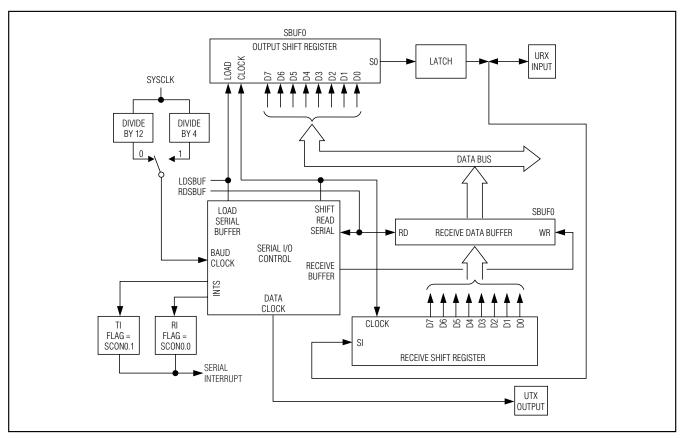


Figure 11a. UART Synchronous Mode (Mode 0)

each incoming message, before accepting an incoming message. This feature allows the CAN unit to directly support the use of higher CAN protocols, which make use of the first and/or second byte of data as a part of the acceptance layer for storing incoming messages. Each message center can also be programmed independently to perform testing of the incoming data with or without the use of the global masks.

Global controls and status registers in the CAN unit allow the  $\mu$ C to evaluate error messages, validate new data and the location of such data, establish the bus timing for the CAN bus, establish the identification mask bits, and verify the source of individual messages. In addition, each message center is individually equipped with the necessary status and controls to establish directions, interrupt generation, identification mode (standard or extended), data field size, data status, automatic remote frame request and acknowledge-

ment, and masked or nonmasked identification acceptance testing.

#### **UART Interface**

Serial interfacing is provided through one (UTX/URX) 8051-style universal synchronous/asynchronous receiver/transmitter (UART) capable of interfacing with a LIN transceiver. Figure 11a shows the UART block diagram in synchronous mode and Figure 11b shows asynchronous mode. The UART allows the device to conveniently communicate with other RS-232 interface-enabled devices, as well as PCs and serial modems when paired with an external RS-232 line driver/receiver. The UART can detect framing errors and indicate the condition through a user-accessible software bit. The time base of the serial port is derived from either a division of the system clock or the dedicated baud clock generator. The UART is capable of supporting LIN protocol implementation in software when using one of the timers for autobaud

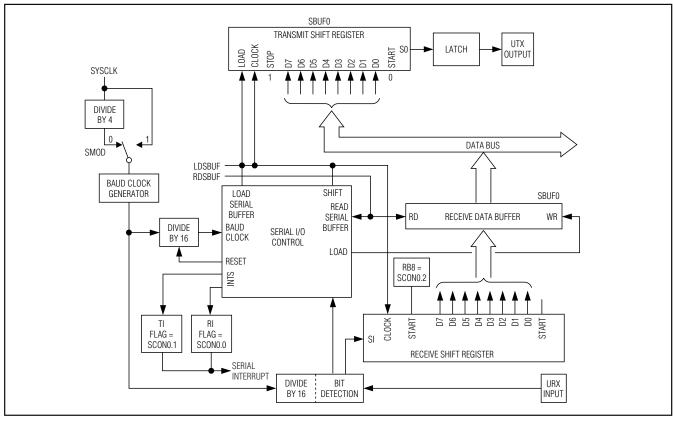


Figure 11b. UART Asynchronous Mode (Mode 1)

detection. Table 1 summarizes the operating characteristics as well as the maximum baud rate of each mode.

#### JTAG Interface Bus

The joint test action group (JTAG) IEEE 1149.1 standard defines a unique method for in-circuit testing and programming. The MAXQ7665A–MAXQ7665D conform to this standard, implementing an external test access port (TAP) and internal TAP controller for communication with a JTAG bus master, such as an automatic test equipment (ATE) system. For detailed information on

the TAP and TAP controller, refer to *IEEE Standard* 1149.1 on the IEEE website at http://standards.ieee.org. The JTAG on the MAXQ7665A–MAXQ7665D is used for in-circuit emulation and debug support, but does not support boundary scan test capability.

The TAP controller communicates synchronously with the host system (bus master) through four digital I/O pins: test mode select (TMS), test clock (TCK), test data input (TDI), and test data output (TDO). The internal TAP module consists of several shift registers and a

Table 1. Operating Characteristics and Mode Baud Rate

| MODE   | TYPE         | BAUD CLOCK      | START BITS | DATA BITS | STOP BITS | MAX BAUD RATE AT<br>8MHz |
|--------|--------------|-----------------|------------|-----------|-----------|--------------------------|
| Mode 0 | Synchronous  | 4 or 12 clock   | N/A        | 8         | N/A       | 2Mbps                    |
| Mode 1 | Asynchronous | Baud generation | 1          | 8         | 1         | 250kbps                  |
| Mode 2 | Asynchronous | 32 or 64 clock  | 1          | 8 + 1     | 1         | 250kbps                  |
| Mode 3 | Asynchronous | Baud generation | 1          | 8 + 1     | 1         | 250kbps                  |

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TAP controller (see Figure 12). The shift registers serve as transmit-and-receive data buffers for a debugger. From a JTAG perspective, shift registers are user-defined optional data registers. The bypass register and the instruction register, for example, are realized as a set of shift-register-based elements connected in parallel between a common serial input (TDI) and a common serial output (TDO). The instruction register, through the TAP controller, selects one of the registers to form an active serial path.

The maximum TCK clock frequency must be below 1/8 of the system clock frequency to work properly. The TAP operates asynchronously with on-chip system logic and may be affected by the timing relation-

ship between the on-chip state machines and the TAP. The on-chip state machines are clocked by the system clock.

The four digital I/Os that form the TAP module are described as follows:

- TDO—Serial output signal for test instruction and data. Data is driven out only on the falling edge of TCK and is forced in an inactive state when it is idle. This signal is used to serially transfer internal data to the host. Data is transferred LSB first.
- TDI—Serial input signal for test instruction and data.
   Data should be driven in only on the rising edge of TCK. This signal is used to serially transfer data from

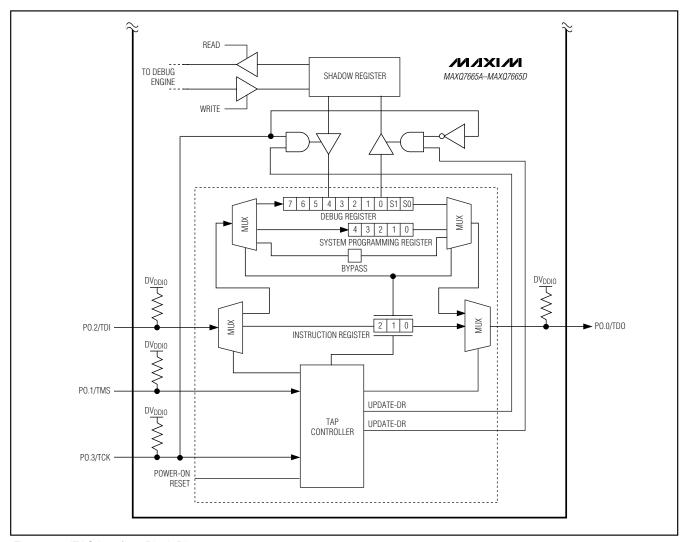


Figure 12. JTAG Interface Block Diagram

the host to the internal TAP module shift registers. Data is transferred LSB first.

- TCK—Serial clock for the test logic.
- TMS—Test mode selection. Test signals received at TMS are sampled at the rising edge of TCK and decoded by the TAP controller to control the test operation.

#### General-Purpose Digital I/Os

The MAXQ7665A–MAXQ7665D provide eight general-purpose digital I/Os (GPIOs). All GPIOs have an additional special function (SF), such as a timer input/output, or TAP signal for JTAG communication. For example, the state of pin P0.6/T0 can be programmed to depend on timer channel 0 logic. When programmed as a port, each I/O is configurable for high-impedance or weak pullup to DVDDIO. At power-up, each GPIO is configured as an input with pullups to DVDDIO. Note that at power-up, the JTAG function is enabled and should be turned off before normal operation. In addition, each GPIO can be programmed to cause an interrupt (on falling or rising edges). In stop mode, any interrupt can be used to wake up the device.

The data input/output direction in a port is independently controlled by the port direction register (PD). Each I/O within the port can be individually set as an output or input. The port output register (PO) contains the current state of the logic output buffers. When an

I/O is configured as an output, writing to the PO register controls the output logic state. Reading the PO register shows the current state of the output buffers, independent of the data direction. The port input register (PI) is a read-only register that always reflects the logic state of the I/Os. When an I/O is configured as an input, writing to the PO register enables/disables the pull-up resistor. Refer to the MAXQ7665/MAXQ7666 User's Guide for more detailed information.

#### Port Characteristics

The MAXQ7665A–MAXQ7665D contain only one port (P0). It is a bidirectional 8-bit I/O port, which contains the following features:

- Schmitt trigger input circuitry with software-selectable high-impedance or weak pullup to DVDDIO
- Software-selectable push-pull CMOS output drivers capable of sinking and sourcing 1.6mA
- Software-selectable open-drain output drivers capable of sinking 1.6mA
- Falling or rising edge interrupt capability
- All I/Os contain an additional special function, such as a logic input/output for a timer channel. Selecting an I/O for a special function alters the port characteristics of that I/O (refer to the MAXQ7665/MAXQ7666 User's Guide for more details). Figure 13 illustrates the functional blocks of an I/O.

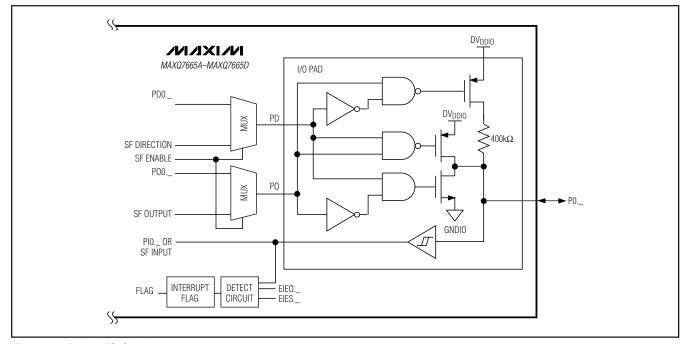


Figure 13. Digital I/O Circuitry

#### **MAXQ Core Architecture**

The MAXQ7665A–MAXQ7665D are low-cost, high-performance, CMOS, fully static, 16-bit  $\mu$ Cs with flash memory and are members of the MAXQ family of  $\mu$ Cs. The MAXQ7665A–MAXQ7665D are structured on a highly advanced, accumulator-based, 16-bit RISC architecture. Fetch and execution operations are completed in one cycle without pipelining, because the instruction contains both the operation code and data. The result is a streamlined 8 million instructions-per-second (MIPS)  $\mu$ C.

The highly efficient core is supported by a 16-level hardware stack, enabling fast subroutine calling and task switching. Data can be quickly and efficiently manipulated with three internal data pointers. Multiple data pointers allow more than one function to access data memory without having to save and restore data pointers each time. The data pointers can automatically increment or decrement following an operation, eliminating the need for software intervention. As a result, application speed is greatly increased.

#### **Instruction Set**

The instruction set is composed of fixed-length, 16-bit instructions that operate on registers and memory locations. The instruction set is highly orthogonal, allowing arithmetic and logical operations to use any register along with the accumulator. Special-function registers (also called peripheral registers) control the peripherals and are subdivided into register modules. The family architecture is modular, so that new devices and modules can reuse code developed for existing products.

The architecture is transport-triggered. This means that writes or reads from certain register locations can also cause side effects to occur. These side effects form the basis for the higher level operation codes defined by the assembler, such as ADDC, OR, JUMP, etc. The operation codes are actually implemented as MOVE instructions between certain register locations, while the assembler handles the encoding, which need not be a concern to the programmer.

The 16-bit instruction word is designed for efficient execution. Bit 15 indicates the format for the source field of the instruction. Bits 0 to 7 of the instruction represent the

source for the transfer. Depending on the value of the format field, this can either be an immediate value or a source register. If this field represents a register, the lower 4 bits contain the module specifier and the upper 4 bits contain the register index in that module.

Bits 8 to 14 represent the destination for the transfer. This value always represents a destination register, with the lower 4 bits containing the module specifier and the upper 3 bits containing the register subindex within that module. Any time that it is necessary to directly select one of the upper 24 registers as a destination, the prefix register, PFX, is needed to supply the extra destination bits. This prefix register write is inserted automatically by the assembler and requires only one additional execution cycle.

### **Memory Organization**

The MAXQ7665A-MAXQ7665D incorporate several memory areas:

- 8KB (4K x 16) utility ROM
- Up to 128KB (64K x 16) of flash memory for program storage
- 512 bytes (256 x 16) of SRAM for storage of temporary variables
- 16-level stack memory for storage of program return addresses and general-purpose use

The memory is arranged by default in a Harvard architecture, with separate address spaces for program and data memory (see Figure 14). A special mode allows data memory to be mapped into program space, permitting code execution from data memory. In addition, another mode allows program memory to be mapped into data space, permitting code constants to be accessed as data memory.

The incorporation of flash memory allows the devices to be reprogrammed, eliminating the expense of throwing away one-time programmable devices during development and field upgrades (see Figure 15 for the flash memory sector maps). Flash memory can be password protected with a 16-word key, denying access to program memory by unauthorized individuals.

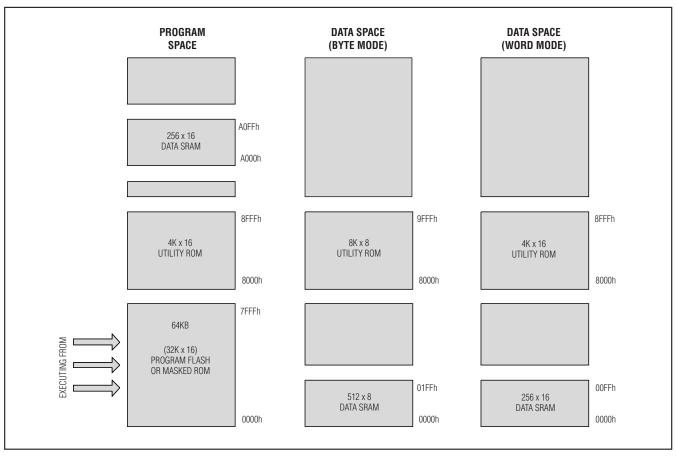


Figure 14. MAXQ7665B Memory Map

A pseudo-Von Neumann memory map can also be enabled. This places the utility ROM, code, and data memory into a single contiguous memory map. This is useful for applications that require dynamic program modification or unique memory configurations.

#### Stack Memory

A 16-bit-wide x 16 deep internal hardware stack provides storage for program return addresses and general-purpose use. The stack is used automatically by the processor when the CALL, RET, and RETI instructions are executed and interrupts serviced. The stack can also be used explicitly to store and retrieve data by using the PUSH, POP, and POPI instructions.

On reset, the stack pointer, SP, initializes to the top of the stack (0Fh). The CALL, PUSH, and interrupt-vectoring

operations increment SP, then store a value at the location pointed to by SP. The RET, RETI, POP, and POPI operations retrieve the value at SP and then decrement SP.

#### **Utility ROM**

The utility ROM is an 8KB (4K x 16) block of internal ROM memory that defaults to a starting address of 8000h. The utility ROM consists of subroutines that can be called from application software. These include:

- In-system programming (bootstrap loader) over JTAG
- In-circuit debug routines
- User-callable routines for in-application flash programming and fast table lookup

\_/N/IXI/N

Following any reset, execution begins in the utility ROM. The ROM software determines whether the program execution should immediately jump to location 0000h, the start of user-application code, or to one of the special routines mentioned. Routines within the utility ROM are user-accessible and can be called as subroutines by the application software. More information on the utility ROM contents is contained in the MAXQ7665/MAXQ7666 User's Guide.

Some applications require protection against unauthorized viewing of program code memory. For these applications, access to in-system programming, inapplication programming, or in-circuit debugging functions is prohibited until a password has been supplied. The password is defined as the 16 words of physical program memory at addresses 0010h to 001Fh.

A single password lock (PWL) bit is implemented in the SC register. When the PWL is set to one (POR default), the password is required to access the utility ROM, including in-circuit debug and in-system programming routines that allow reading or writing of internal memory. When PWL is cleared to zero, these utilities are fully accessible without the password. The password is automatically set to all ones following a mass erase.

#### **Programming**

The flash memory of the  $\mu$ C can be programmed by two different methods: in-system programming and inapplication programming. Both methods afford great flexibility in system design as well as reduce the lifecycle cost of the embedded system. These features can be password protected to prevent unauthorized access to program memory.

#### In-System Programming

An internal bootstrap loader allows the device to be reloaded over a simple JTAG interface. As a result, software can be upgraded in-system, eliminating the need for a costly hardware retrofit when updates are required. Remote software uploads are possible that enable physically inaccessible applications to be frequently updated. The interface hardware can be a JTAG connection to another  $\mu C$ , or a connection to a PC serial port using a serial-to-JTAG converter such as the MAXQJTAG-001, available from Maxim Integrated Products, Inc. If in-system programmability is not required, a commercial gang programmer can be used for mass programming.

After a power-up or reset, the JTAG interface is active and loading the TAP with the system programming instruction invokes the bootstrap loader. Setting the SPE bit to 1 during reset through the JTAG interface executes the bootstrap-loader-mode program that resides in the utility ROM. When programming is complete, the bootstrap loader can clear the SPE bit and reset the device, allowing the device to bypass the utility ROM and begin execution of the application software.

The following bootstrap loader functions are supported:

- Load
- Dump
- CRC
- Verify
- Erase

#### In-Application Programming

The in-application programming feature allows the  $\mu$ C to modify its own flash program memory while simultaneously executing its application software. This allows onthe-fly software updates in mission-critical applications that cannot afford downtime. Alternatively, it allows the application to develop custom loader software that can operate under the control of the application software. The utility ROM contains user-accessible flash programming functions that erase and program flash memory. These functions are described in detail in the MAXQ7665/MAXQ7666 User's Guide for these devices.

### \_Register Set

Most functions of these devices are controlled by sets of registers. These registers provide a working space for memory operations as well as configuring and addressing peripheral registers on the device. Registers are divided into two major types: system registers and peripheral registers. The common register set, also known as the system registers, includes the ALU, accumulator registers, data pointers, interrupt vectors and control, and stack pointer. The peripheral registers define additional functionality that may be included by different products based on the MAXQ architecture. This functionality is broken up into discrete modules so that only the features required for a given product need to be included. Tables 2 and 4 show the MAXQ7665A-MAXQ7665D register set. Tables 3 and 5 show the bit functions and reset values.



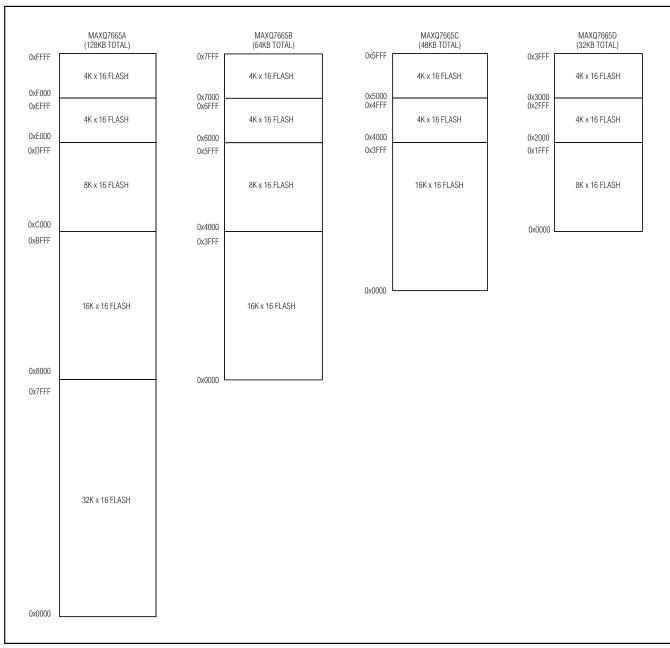


Figure 15. Flash Memory Sector Maps

#### Power Management

Advanced power-management features minimize power consumption by dynamically matching the processing speed of the device to the required performance level. This means device operation can be slowed and power consumption minimized during periods of reduced activity. When more processing power is required, the  $\mu C$  can increase its operating frequency. Software-selectable clock-divide operations allow flexibility, selecting whether a system clock cycle is one, two, four, or eight oscillator cycles. By performing this function in software, a lower power state can be entered without the cost of additional hardware.

For extremely power-sensitive applications, two additional low-power modes are available:

- PMM: divide-by-256 power-management mode (PMME = 1, CD1:0 = 00b)
- Stop mode (STOP = 1)

In PMM, one system clock is 256 oscillator cycles, significantly reducing power consumption while the  $\mu$ C functions at reduced speed. The optional switchback feature allows enabled interrupt sources including external interrupts, UART, and CAN, to quickly exit the power-management mode and return to a faster internal clock rate.

Power consumption reaches its minimum in stop mode. In this mode, the external oscillator, internal RC oscillator, system clock, and all processing activity is halted. Stop mode is exited when an enabled external interrupt input is triggered or an external reset signal is applied to  $\overline{\text{RESET}}.$  Upon exiting stop mode, the  $\mu\text{C}$  can choose to wait for the external high-frequency crystal to complete its warmup period, or it can start execution immediately from its internal RC oscillator while the warmup period completes.

**Table 2. System Register Map** 

| REGISTER | MODULE NAME (BASE SPECIFIER) |        |          |         |         |          |         |  |  |  |
|----------|------------------------------|--------|----------|---------|---------|----------|---------|--|--|--|
| INDEX    | AP (8h)                      | A (9h) | PFX (Bh) | IP (Ch) | SP (Dh) | DPC (Eh) | DP (Fh) |  |  |  |
| 0h       | AP                           | A[0]   | PFX[0]   | IP      | _       | _        | _       |  |  |  |
| 1h       | APC                          | A[1]   | PFX[1]   | _       | SP      | _        | _       |  |  |  |
| 2h       | _                            | A[2]   | PFX[2]   | _       | IV      | _        | _       |  |  |  |
| 3h       | _                            | A[3]   | PFX[3]   | _       | _       | OFFS     | DP0     |  |  |  |
| 4h       | PSF                          | A[4]   | PFX[4]   | _       | _       | DPC      | _       |  |  |  |
| 5h       | IC                           | A[5]   | PFX[5]   | _       | _       | GR       | _       |  |  |  |
| 6h       | IMR                          | A[6]   | PFX[6]   | _       | LC0     | GRL      | _       |  |  |  |
| 7h       | _                            | A[7]   | PFX[7]   | _       | LC1     | BP       | DP1     |  |  |  |
| 8h       | SC                           | A[8]   |          | _       | _       | GRS      | _       |  |  |  |
| 9h       | _                            | A[9]   | _        | _       | _       | GRH      | _       |  |  |  |
| Ah       | _                            | A[10]  | _        | _       | _       | GRXL     | _       |  |  |  |
| Bh       | IIR                          | A[11]  | _        | _       | _       | FP       | _       |  |  |  |
| Ch       | _                            | A[12]  | _        | _       | _       | _        | _       |  |  |  |
| Dh       | _                            | A[13]  |          |         | _       |          |         |  |  |  |
| Eh       | CKCN                         | A[14]  | _        | _       | _       | _        | _       |  |  |  |
| Fh       | WDCN                         | A[15]  |          |         |         |          |         |  |  |  |

**Note:** Names that appear in italics indicate that all bits of a register are read-only. Names that appear in bold indicate that a register is 16 bits wide.



### Interrupts

Multiple interrupt sources are available for quick response to internal and external events. The MAXQ architecture uses a single interrupt vector (IV), single interrupt-service routine (ISR) design. For maximum flexibility, interrupts can be enabled globally, individually, or by module. When an interrupt condition occurs, its individual flag is set, even if the interrupt source is disabled at the local, module, or global level. Interrupt flags must be cleared within the user-interrupt routine to avoid repeated false interrupts from the same source. Application software must ensure a delay between the write to the flag and the RETI instruction to allow time for the interrupt hardware to remove the internal interrupt condition. Asynchronous interrupt flags require a one-instruction delay and synchronous interrupt flags require a two-instruction delay.

When an enabled interrupt is detected, software jumps to a user-programmable interrupt vector location. The IV register defaults to 0000h on reset or power-up, so if it is not changed to a different address, the user program must determine whether a jump to 0000h came from a reset or interrupt source.

Once software control has been transferred to the ISR, the interrupt identification register (IIR) can be used to determine if a system register or peripheral register was the source of the interrupt. The specified module can then be interrogated for the specific interrupt source and software can take appropriate action. Because the interrupts are evaluated by user software, the user can define a unique interrupt priority scheme for each application. The following interrupt sources are available.

- Watchdog interrupt
- External interrupts 0 to 7
- Serial port 0 receive and transmit interrupts

- Timer 0 low compare, low overflow, capture/compare, and overflow interrupts
- Timer 1 low compare, low overflow, capture/compare, and overflow interrupts
- Timer 2 low compare, low overflow, and overflow interrupts
- CAN0 receive and transmit interrupts and a change in CAN0 status register interrupt
- ADC data ready and overrun interrupts
- Digital and I/O voltage brownout interrupts
- High-frequency oscillator failure interrupt

#### **Reset Sources**

Several reset sources are provided for  $\mu C$  control. Although code execution is halted in the reset state, the high-frequency oscillators and the internal RC oscillator continue to oscillate. The high-frequency oscillator is turned off by a POR, but not by other reset sources. Internal resets such as the power-on and watchdog resets assert the  $\overline{\text{RESET}}$  output low.

#### Power-On Reset (POR)

An internal POR circuit enhances system reliability. This circuit forces the device to perform a POR whenever a rising voltage on DVDD climbs above the POR threshold level of 2.7V. At this point the following events occur:

- All registers and circuits enter their reset state
- The POR flag (WDCN.POR) is set to indicate the source of the reset
- The internal RC oscillator becomes the clock source
- Code execution begins at location 8000h

#### **Watchdog Timer Reset**

The watchdog timer functions are described in the *MAXQ7665/MAXQ7666 User's Guide*. Execution resumes at location 8000h following a watchdog timer reset.

### **External System Reset**

Asserting the external RESET input low causes the device to enter the reset state. The external reset functions as described in the MAXQ7665/MAXQ7666 User's Guide. Execution resumes at location 8000h after RESET is released.

### **Crystal Selection**

The MAXQ7665A-MAXQ7665D require a crystal with the following specifications:

Frequency: 1MHz to 8MHz

CLOAD: 6pF (min) Drive level: 5µW

Series resonance resistance:  $30\Omega$  max

**Note:** Series resonance resistance is the resistance observed when the resonator is in the series resonant condition. This is a parameter often stated by quartz crystal vendors and is called R1. When a resonator is used in the parallel resonant mode with an external load capacitance, as is the case with the MAXQ7665A–MAXQ7665D oscillator circuit, the effective resistance is sometimes stated. This effective resistance at the loaded frequency of oscillation is:

 $R1 \times (1 + (C_O/C_{LOAD}))^2$ 

For typical C<sub>O</sub> and C<sub>LOAD</sub> values, the effective resistance can be greater than R1 by a factor of 2.

### **Development and Technical Support**

A variety of highly versatile, affordably priced development tools for this  $\mu C$  are available from Maxim and third-party suppliers, including:

- Compilers
- Evaluation kits
- Integrated development environments (IDEs)
- JTAG-to-serial converters for programming and debugging

A list of some development-tool vendors can be found at <a href="https://www.maxim-ic.com/microcontrollers">www.maxim-ic.com/microcontrollers</a>.

Technical support is available through email at maxq.support@maxim-ic.com.

**Table 3. System Register Bit Functions and Reset Values** 

| AP   | REGISTER     |      |      |      |      |      |      |      | REG  | ISTER BIT   | Г  |      |     |   |    |     |     |
|--|--------------|------|------|------|------|------|------|------|------|-------------|----|------|-----|---|----|-----|-----|
| APC APC APC APC BY   | REGISTER     | 15   | 14   | 13   | 12   | 11   | 10   | 9    | 8    | 7           | 6  | 5    | 4   | 3 |    |     | 0   |
| APC  APC  BYSE  APC  APC  BYSE  APC  APC  BYSE  APC  APC  BYSE  APC  APC  APC  APC  APC  APC  APC  AP  | AP           |      |      |      |      |      |      |      |      | _           | _  | _    | _   | _ |    |     | T 0 |
| PSF  |              |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| PSF  | APC          |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| PSP  |              |      |      |      |      |      |      |      |      |             |    | _    |     |   |    |     |     |
| MR   | PSF          |      |      |      |      |      |      |      |      |             |    | 0    |     |   |    |     |     |
| MR   | IC           |      |      |      |      |      |      |      |      |             | _  | CGDS | -   | _ | _  | INS | IGE |
| SC   SC   SC   SC   SC   SC   SC   SC  | 10           |      |      |      |      |      |      |      |      |             | 0  |      |     |   |    |     |     |
| SC   | IMR          |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| SC   |              |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| IR   | SC           |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| CKCN   |              |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| CKCN   | IIR          |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     | 1   |
| CRCN   |              |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| WOCN   | CKCN         |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| A n  (0.15)  | MECH         |      |      |      |      |      |      |      |      |             |    |      | WD0 |   |    |     | RWT |
| PFX[n] (0.16)  | WDCN         |      |      |      |      |      |      |      |      | s*          | s* | 0    | 0   | 0 | s* | s*  | 0   |
| PFX[n] (015)   | Λ[n] (0, 15) |      |      |      |      |      |      |      | A[n] | ] (16 Bits) |    |      |     |   |    |     |     |
| P  | A[11] (015)  | 0    | 0    | 0    | 0    | 0    | 0    | 0    |      |             |    | 0    | 0   | 0 | 0  | 0   | 0   |
| P  | PFX[n] (015) |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
|  | 1 1(1 1)     | 0    | 0    | 0    | 0    | 0    | 0    | 0    |      |             | 0  | 0    | 0   | 0 | 0  | 0   | 0   |
| SP   | IP           |      |      | _    |      | _    |      | 0    |      |             |    |      | 0   |   |    |     |     |
| SP   |              |      |      |      | U    |      |      |      |      | U           |    | U    | 0   | U | _  |     | U   |
| N  | SP           |      |      |      | _    |      |      |      |      | 0           |    |      |     | 1 |    |     | 1   |
| Close  |              | 0    | 0    | 0    | U    | U    | U    | U    |      |             | U  | U    | 0   |   |    |     |     |
| LC[0]   C[0]   C | IV           | 0    | 0    | 0    | 0    | 0    | 0    | 0    |      | `           | 0  | 0    | 0   | 0 | 0  | 0   | 0   |
| LC[1]  | 1.0101       |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| OFFS OFFS OFFS OFFS OFFS OFFS OFFS OFFS  | LC[0]        | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0           | 0  | 0    | 0   | 0 | 0  | 0   | 0   |
| OFFS    O  | 1.0[1]       |      |      |      |      |      |      |      | LC[1 | ] (16 Bits) |    |      |     |   |    |     |     |
| DPC  | LO[1]        | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0           | 0  | 0    |     |   | 0  | 0   | 0   |
| DPC  | OFFS         |      |      |      |      |      |      |      |      |             |    |      |     |   |    | 1   | 1   |
| DPC  O O O O O O O O O O O O O O O O O O   |              |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| GR. 15 GR. 14 GR. 13 GR. 12 GR. 11 GR. 10 GR. 9 GR. 8 GR. 7 GR. 6 GR. 5 GR. 4 GR. 3 GR. 2 GR. 1 GR. 0  GRL  GRL  GRL  GRL  GRL  GRL  GRL  GR   | DPC          |      |      |      | _    |      | _    |      |      |             |    |      |     |   |    |     |     |
| GRL  GRL  GRL  GRL  GR.7  GR.6  GR.7                | -    |      |      |      | _    |      |      |      |             |    |      |     | - |    |     |     |
| GRL    GR.   | GR           |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| BP  O O O O O O O O O O O O O O O O O O O  | 0.51         |      |      |      | Ĭ    |      | J    | Ť    |      |             |    |      |     |   |    |     |     |
| BP   | GRL          |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| GRS GR.7 GR.6 GR.5 GR.4 GR.3 GR.2 GR.1 GR.0 GR.15 GR.14 GR.13 GR.12 GR.11 GR.10 GR.9 GR.8  GRH GR.7 GR.7 GR.7 GR.7 GR.7 GR.7 GR.7 GR.7   | RD           |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| GRS  0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0   | DF           |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| GRH  GRY  GRY  GRY  GRY  GRY  GRY  GRY   | GRS          |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| GRH  GRX  GR.7 GR.7 GR.7 GR.7 GR.7 GR.7 GR.7 GR.7  |              | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    |             |    |      |     |   |    |     |     |
| GRXL GR.7 GR.7 GR.7 GR.7 GR.7 GR.7 GR.7 GR.7   | GRH          |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| PP[1]  |              | CD 7 |             |    |      |     |   |    |     |     |
| FP   Temperature   FP   Temperat | GRXL         |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
| PP 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0   |              | 0    |      |      |      | U    | U    | U    |      |             |    | U    | U   |   |    |     |     |
| DP[0] 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0  | FP FP        | 0    | 0    | 0    | 0    | 0    | 0    | 0    |      | `           | 0  | 0    | 0   | 0 | 0  | 0   | 0   |
| DP[0] 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0  | DDIO         |      |      |      |      |      |      |      |      |             |    |      |     |   |    |     |     |
|  | DP[0]        | 0    | 0    | 0    | 0    | 0    | 0    | 0    |      |             | 0  | 0    | 0   | 0 | 0  | 0   | 0   |
|  | DP[1]        |      |      |      |      |      |      |      | DP[1 | ] (16 Bits) |    |      |     |   |    |     |     |
|  |              | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0    | 0           | 0  | 0    | 0   | 0 | 0  | 0   | 0   |

<sup>\*</sup>Bits indicated by an "s" are only affected by a POR and not by other forms of reset. These bits are set to 0 after a POR. Refer to the MAXQ7665/MAXQ7666 User's Guide for more information.

**Table 4. Peripheral Register Map** 

| REGISTER |         |          | MODULE NAME ( | BASE SPECIFIER) | )       |         |
|----------|---------|----------|---------------|-----------------|---------|---------|
| INDEX    | M0 (0h) | M1 (1h)  | M2 (2h)       | M3 (3h)         | M4 (4h) | M5 (5h) |
| 0h       | PO0     | MCNT     | T2CNA0        | T2CNA2          | COC     | VMC     |
| 1h       | _       | MA       | T2H0          | T2H2            | COS     | APE     |
| 2h       | _       | MB       | T2RH0         | T2RH2           | COIR    | ACNT    |
| 3h       | EIF0    | MC2      | T2CH0         | T2CH2           | COTE    | DCNT    |
| 4h       | _       | MC1      | T2CNA1        | _               | C0RE    | DACI    |
| 5h       | _       | MC0      | T2H1          | _               | COR     | _       |
| 6h       | _       | _        | T2RH1         | _               | C0DP    | DACO    |
| 7h       | SBUF0   | _        | T2CH1         | _               | CODB    | _       |
| 8h       | PI0     | _        | T2BNB0        | T2CNB2          | CORMS   | ADCD    |
| 9h       | _       | _        | T2V0          | T2V2            | C0TMA   | TSO     |
| Ah       | _       | FCNTL    | T2R0          | T2R2            | _       | AIE     |
| Bh       | EIE0    | FDATA    | T2C0          | T2C2            | _       | ASR     |
| Ch       | _       | MC1R     | T2CNB1        | _               | _       | OSCC    |
| Dh       | _       | MC0R     | T2V1          | _               | _       | _       |
| Eh       | _       | _        | T2R1          | _               | _       | _       |
| Fh       | _       | _        | T2C1          | _               | _       | _       |
| 10h      | PD0     | _        | T2CFG0        | T2CFG2          | _       | _       |
| 11h      | _       | _        | T2CFG1        | _               | C0M1C   | _       |
| 12h      | _       | _        | _             | _               | C0M2C   | _       |
| 13h      | EIES0   | _        | _             | _               | C0M3C   | _       |
| 14h      | _       | _        | _             | _               | C0M4C   | _       |
| 15h      | _       | _        | _             | _               | C0M5C   | _       |
| 16h      | _       | _        | _             | _               | C0M6C   | _       |
| 17h      | _       | _        | _             | _               | C0M7C   | _       |
| 18h      | _       | _        | ICDT0         | _               | C0M8C   | _       |
| 19h      | _       | _        | ICDT1         | _               | C0M9C   | _       |
| 1Ah      | _       | _        | ICDC          | _               | C0M10C  | _       |
| 1Bh      | _       | _        | ICDF          | _               | C0M11C  | _       |
| 1Ch      | _       | Reserved | ICDB          | _               | C0M12C  | _       |
| 1Dh      | SCON0   | _        | ICDA          | _               | C0M13C  | _       |
| 1Eh      | SMD0    | _        | ICDD          | _               | C0M14C  | _       |
| 1Fh      | PR0     | _        | _             | _               | C0M15C  | _       |
|          |         | 1        | 1             | 1               | 1       | 1       |

**Note:** Names that appear in bold indicate that the register is read-only.

Table 5. Peripheral Register Bit Functions and Reset Values

| REGISTER   |          |          |          |          |          |          |         | REGISTER BIT | BIT     |              |         |         |         |         |         |         |
|------------|----------|----------|----------|----------|----------|----------|---------|--------------|---------|--------------|---------|---------|---------|---------|---------|---------|
| 000        | 15       | 14       | 13       | 12       | 11       | 10       | 6       | 8            | 7       | 9            | 2       | 4       | 3       | 2       | ٠       | 0       |
| 90         |          | _        | _        | _        | _        | -        | _       | _            | PO0.7   | 9.00A        | PO0.5   | PO0.4   | PO0.3   | PO0.2   | PO0.1   | PO0.0   |
| (INO, OII) | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 1       | 1            | 1       | 1       | 1       | 1       | 1       | 1       |
| EIFO       |          | _        | _        | _        | _        |          | _       | _            | IE7     | 9 <b>3</b> 1 | IE5     | IE4     | IE3     | IE2     | IE1     | IE0     |
| (M0, 3h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| SBUF0      |          | 1        | -        | -        |          |          |         |              | SBUF0.7 | SBUF0.6      | SBUF0.5 | SBUF0.4 | SBUF0.3 | SBUF0.2 | SBUF0.1 | SBUF0.0 |
| (MO, 7h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| PIO        |          | _        | _        | _        | _        |          | _       | _            | PI0.7   | 9:0IA        | PI0.5   | P10.4   | PI0.3   | P10.2   | PI0.1   | PI0.0   |
| (M0, 8h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | ST      | ST           | ST      | ST      | ST      | ST      | ST      | ST      |
| EIEO       | Ι        | -        | -        | -        |          |          |         | 1            | EX7     | EX6          | EX5     | EX4     | EX3     | EX2     | EX1     | EXO     |
| (M0, Bh)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| PD0        | Ι        | -        |          |          | 1        |          | Ι       |              | PD0.7   | 9.0QA        | PD0.5   | PD0.4   | PD0.3   | PD0.2   | PD0.1   | PD0.0   |
| (M0, 10h)  | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| EIES0      | Ι        | -        | -        | -        |          |          |         | 1            | IT7     | IT6          | IT5     | IT4     | П3      | IT2     | П       | IT0     |
| (M0, 13h)  | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| SCONO      |          | _        | _        | _        | -        |          | -       | -            | SM0/FE  | SM1          | SM2     | REN     | TB8     | RB8     | Ш       | RI      |
| (M0, 1Dh)  | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| SMD0       | Ι        | -        | -        | -        |          |          |         | 1            | I       |              | I       |         | 1       | ESI     | SMOD    | FEDE    |
| (M0, 1Eh)  | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| PRO        | PR0.15   | PR0.14   | PR0.13   | PR0.12   | PR0.11   | PR0.10   | PR0.9   | PR0.8        | PR0.7   | PR0.6        | PR0.5   | PR0.4   | PR0.3   | PR0.2   | PR0.1   | PR0.0   |
| (M0, 1Fh)  | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| MCNT       | Ι        |          |          |          |          |          |         | 1            | OF      | MCW          | CLD     | SQU     | OPCS    | MSUB    | MMAC    | SUS     |
| (M1, 0h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| MA         | MA.15    | MA.14    | MA.13    | MA.12    | MA.11    | MA.10    | MA.9    | MA.8         | MA.7    | MA.6         | MA.5    | MA.4    | MA.3    | MA.2    | MA.1    | MA.0    |
| (M1, 1h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| MB         | MB.15    | MB.14    | MB.13    | MB.12    | MB.11    | MB.10    | MB.9    | MB.8         | MB.7    | MB.6         | MB.5    | MB.4    | MB.3    | MB.2    | MB.1    | MB.0    |
| (M1, 2h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| MC2        | MC2.15   | MC2.14   | MC2.13   | MC2.12   | MC2.11   | MC2.10   | MC2.9   | MC2.8        | MC2.7   | MC2.6        | MC2.5   | MC2.4   | MC2.3   | MC2.2   | MC2.1   | MC2.0   |
| (M1, 3h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| MC1        | MC1.15   | MC1.14   | MC1.13   | MC1.12   | MC1.11   | MC1.10   | MC1.9   | MC1.8        | MC1.7   | MC1.6        | MC1.5   | MC1.4   | MC1.3   | MC1.2   | MC1.1   | MC1.0   |
| (M1, 4h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| MC0        | MC0.15   | MC0.14   | MC0.13   | MC0.12   | MC0.11   | MC0.10   | MC0.9   | MC0.8        | MC0.7   | MC0.6        | MC0.5   | MC0.4   | MC0.3   | MC0.2   | MC0.1   | MC0.0   |
| (M1, 5h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| FCNTL      | 1        | 1        | 1        | 1        | 1        | 1        |         |              | FBUSY   | FERR         | FINE    | FBYP    | DQ5     | FC2     | FC1     | 1       |
| (M1, Ah)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | -       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| FDATA      | FDATA.15 | FDATA.14 | FDATA.13 | FDATA.12 | FDATA.11 | FDATA.10 | FDATA.9 | FDATA.8      | FDATA.7 | FDATA.6      | FDATA.5 | FDATA.4 | FDATA.3 | FDATA.2 | FDATA.1 | FDATA.0 |
| (M1, Bh)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| MC1R       | MC1R.15  | MC1R.14  | MC1R.13  | MC1R.12  | MC1R.11  | MC1R.10  | MC1R.9  | MC1R.8       | MC1R.7  | MC1R.6       | MC1R.5  | MC1R.4  | MC1R.3  | MC1R.2  | MC1R.1  | MC1R.0  |
| (M1, Ch)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| MC0R       | MC0R.15  | MC0R.14  | MC0R.13  | MC0R.12  | MC0R.11  | MC0R.10  | MC0R.9  | MC0R.8       | MC0R.7  | MC0R.6       | MC0R.5  | MC0R.4  | MC0R.3  | MC0R.2  | MC0R.1  | MC0R.0  |
| (M1, Dh)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| T2CNA0     | Ι        | _        | -        | -        |          |          |         | 1            | ET2     | T20E0        | T2POL0  | TR2L    | TR2     | CPRL2   | SS2     | G2EN    |
| (M2, Oh)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |
| T2H0       |          | _        | _        | _        | -        |          | -       | -            | T2H0.7  | T2H0.6       | T2H0.5  | T2H0.4  | T2H0.3  | T2H0.2  | T2H0.1  | T2H0.0  |
| (M2, 1h)   | 0        | 0        | 0        | 0        | 0        | 0        | 0       | 0            | 0       | 0            | 0       | 0       | 0       | 0       | 0       | 0       |

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# MAXQ7665A-MAXQ7665D

16-Bit RISC Microcontroller-Based Smart Data-Acquisition Systems

| REGISTER            |                |              |                |              |                |                 |               | REGISTERED BIT | D BIT       |               |              |             |   |                |               |              |
|---------------------|----------------|--------------|----------------|--------------|----------------|-----------------|---------------|----------------|-------------|---------------|--------------|-------------|---|----------------|---------------|--------------|
| TORHO               | 15             | 14           | 13             | 12           | 11             | 10              | 6             | 8              | 7           | 9             | 2            | 4           | 3   | 2              | -             | 0            |
| (M2. 2h)            | 1              |              | I              |              | I              |                 | I             | 1              | T2RH0.7     | T2RH0.6       | T2RH0.5      | T2RH0.4     | T2RH0.3   | T2RH0.2        | T2RH0.1       | T2RH0.0      |
| (1111)              | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2CH0               | 0              | <            | 0              | <            | 0              | <               | <             | 0              | T2CH0.7     | T2CH0.6       | T2CH0.5      | T2CH0.4     | T2CH0.3   | T2CH0.2        | T2CH0.1       | T2CH0.0      |
| TOCNA1              | >              | >            | >              | >            | >              | >               | >             | >              | ET2         | T20F0         | T2POL0       | TR2L        | TR2   | CPRI 2         | SS2           | GZEN         |
| (M2, 4h)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2H1                |                | I            | 1              | 1            | I              | I               | 1             |                | T2H1.7      | T2H1.6        | T2H1.5       | T2H1.4      | T2H1.3  | T2H1.2         | T2H1.1        | T2H1.0       |
| (M2, 5h)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2RH1               | •              |              |                |              |                |                 |               |                | T2RH1.7     | T2RH1.6       | T2RH1.5      | T2RH1.4     | T2RH1.3   | T2RH1.2        | T2RH1.1       | T2RH1.0      |
| (M2, 6h)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 1000        | 0 20          | 0 20         | 0           | 0   | 0 20           | 0 2           | 0 200        |
| T2CH1               | •              | (            |                | 0            | (              | (               |               | 0              | 12CH1.7     | 12CH1.6       | 12CH1.5      | 12CH1.4     | 12CH1.3   | 12CH1.2        | 12CH1.1       | 12CH1.0      |
| (MZ, /h)            | 0              | Э            | 0              | 0            | 0              | 0               | 0             | 0              | 0 5         | 0             | Э            | 0           | 0 4   | 0 10           | 0             | 0 50         |
| (M2 8h)             | 0              | <            | <              | <            | 0              | <               | <             | <              | E I Z L     | 0             | 0            | 0           | ZZ C  | I FZL          | SOS           | J.S.F        |
| (INIZ, OII)<br>T2V0 | T2V0.15        | T2V0.14      | T2V0.13        | T2V0.12      | T2V0.11        | T2V0.10         | T2V0.9        | T2V0.8         | T2V0.7      | T2V0.6        | T2V0.5       | T2V0.4      | T2V0.3  | T2V0.2         | T2V0.1        | T2V0.0       |
| (M2, 9h)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2R0                | T2R0.15        | T2R0.14      | T2R0.13        | T2R0.12      | T2R0.11        | T2R0.10         | T2R0.9        | T2R0.8         | T2R0.7      | T2R0.6        | T2R0.5       | T2R0.4      | T2R0.3  | T2R0.2         | T2R0.1        | T2R0.0       |
| (M2, Ah)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| 12C0                | T2C0.15        | T2C0.14      | T2C0.13        | T2C0.12      | T2C0.11        | T2C0.10         | T2C0.9        | T2C0.8         | T2C0.7      | T2C0.6        | T2C0.5       | T2C0.4      | T2C0.3  | T2C0.2         | T2C0.1        | T2C0.0       |
| (MZ, Brl)<br>T2CNB1 | >              | >            | >              | >            | >              | o               | >             | o              | D ET2       | >             | >            | >           | O L   | O LESI         | O TOU         | O L          |
| (M2, Ch)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2V1                | T2V1.15        | T2V1.14      | T2V1.13        | T2V1.12      | T2V1.11        | T2V1.10         | T2V1.9        | T2V1.8         | T2V1.7      | T2V1.6        | T2V1.5       | T2V1.4      | T2V1.3  | T2V1.2         | T2V1.1        | T2V1.0       |
| (M2, Dh)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2R1                | T2R1.15        | T2R1.14      | T2R1.13        | T2R1.12      | T2R1.11        | T2R1.10         | T2R1.9        | T2R1.8         | T2R1.7      | T2R1.6        | T2R1.5       | T2R1.4      | T2R1.3  | T2R1.2         | T2R1.1        | T2R1.0       |
| (M2, Eh)            | 0              | 0 7          | 0              | 0 7          | 0              | 0               | 0             | 0              | 0           | 0 700         | 0            | 0           | 0   | 0 700          | 0 7           | 0 700        |
| M2 EN               | 12C1.15        | 1201.14      | 1201.13        | 1201.12      | 120.11         | 01.10           | 12C L3        | 8.1.28         | 1201./      | 0. I.S        | 12C I.5      | 1201.4      | 5.1.3   | 1201.2         | 1.105         | 0.1.0        |
| TZCFG0              | >              | >            | >              | >            | >              | »               | >             | »              | )           | T2DIV2        | T2DIV1       | T2DIV0      | TZMD  | COF1           | CCF0          | C/T2         |
| (M2, 10h)           | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2CFG1              | I              | I            | I              | I            | I              | I               | I             |                |             | T2DIV2        | T2DIV1       | T2DIV0      | T2MD  | CCF1           | CCF0          | C/T2         |
| (M2, 11b)           | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| ICDT0               | ICDT0.15       | ICDT0.14     | ICDT0.13       | ICDT0.12     | ICDT0.11       | ICDT0.10        | ICDT0.9       | ICDT0.8        | ICDT0.7     | ICDT0.6       | ICDT0.5      | ICDT0.4     | ICDT0.3   | ICDT0.2        | ICDT0.1       | ICDT0.0      |
| (MZ, I8n)           | DB<br>ICDT4 46 | UB           | DB<br>ICDT4 43 | UB           | UB<br>ICDT4 41 | DB<br>ICDIT4 40 | DB<br>ICDT4.0 | DB<br>ICDIT 0  | DB 7        | DB<br>ICDT16  | DB<br>PT-T-1 | DB<br>ICDI1 | DE COLLEGE  | UB<br>ICDIT4.2 | DE L          | DB<br>ICDITA |
| (M2, 19h)           | DB             | DB DB        | DB             | DB           | DB             | DB              | DB            | DB DB          | DB          | DB            | DB DB        | DB DB       | DB  | DB             | DB            | DB           |
| ICDC                |                | I            | I              | 1            | ı              | 1               | I             | 1              | DME         | I             | REGE         | 1           | CMD3  | CMD2           | CMD1          | CMD0         |
| (M2, 1Ah)           | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | MQ          | 0             | MQ           | 0           | MO  | MO             | WO            | MO           |
| (M2 1Bh)            | 0              | 0            | 0              | c            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | c           | ,<br>00<br>00<br>00<br>00<br>00<br>00<br>00<br>00<br>00<br>00<br>00<br>00<br>00 | 000            | ا<br>ا        | 2            |
| ICDB                |                | ·            |                |              | )              | )               |               | )              | ICDB.7      | ICDB.6        | ICDB.5       | ICDB.4      | ICDB.3  | ICDB.2         | ICDB.1        | ICDB.0       |
| (M2, 1Ch)           | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| ICDA<br>Age         | ICDA. 15       | ICDA.14      | ICDA. 13       | ICDA.12      | ICDA.11        | ICDA.10         | ICDA.9        | ICDA.8         | ICDA.7      | ICDA.6        | ICDA.5       | ICDA.4      | ICDA.3  | ICDA.2         | ICDA.1        | ICDA.0       |
| MZ, IDN)            | 0<br>ICDD 15   | U<br>ICDD 14 | U<br>ICDD 13   | U<br>ICDD 12 | UCDD 11        | 0 000           | 0 0001        | 0 0001         | 0 1000      | 0 000         | 0            | U<br>ICDD 4 | 0 000   | 0 000          | 0             | 0 000        |
| (M2, 1Eh)           | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2CNA2              | 1              | 1            | 1              | 1            | 1              | 1               | 1             | 1              | ET2         | T20E0         | T2POL0       | TR2L        | TR2   | CPRL2          | SS2           | G2EN         |
| (M3, 0h)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
| T2H2                | 1              | 1            |                | 1            |                | 1               |               |                | T2H2.7      | T2H2.6        | T2H2.5       | T2H2.4      | T2H2.3  | T2H2.2         | T2H2.1        | T2H2.0       |
| (M3, 1h)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0<br>T2DH27 | 0<br>TODILO 6 | 120H2 F      | 0           | 0   | 120122         | 10<br>TOBHO 1 | 120120       |
| (M3 2h)             | 0              | 0            | c              | c            | 0              | 0               | 0             | 0              | 12HHZ./     | 12HHZ.6       | 12HHZ.5      | 12KH2.4     | 12HHZ.3   | 1.2HH2.2       | 12KHZ.1       | IZHHZ.U      |
| T2CH2               | >              | >            | >              | ,            | >              | »               | >             | ,              | T2CH2.7     | T2CH2.6       | T2CH2.5      | T2CH2.4     | T2CH2.3   | T2CH2.2        | T2CH2.1       | T2CH2.0      |
| (M3, 3h)            | 0              | 0            | 0              | 0            | 0              | 0               | 0             | 0              | 0           | 0             | 0            | 0           | 0   | 0              | 0             | 0            |
|                     |                |              |                |              |                |                 |               |                |             |               |              |             |   | -              |               |              |

MIXIM

Table 5. Peripheral Register Bit Functions and Reset Values (continued)

Table 5. Peripheral Register Bit Functions and Reset Values (continued)

| REGISTER            |          |           |           |           |          |           |           | REGISTER BIT | ВІТ      |          |         |                  |           |              |           |         |
|---------------------|----------|-----------|-----------|-----------|----------|-----------|-----------|--------------|----------|----------|---------|------------------|-----------|--------------|-----------|---------|
| T2CNB2              | 15       | 14        | 13        | 12        | 1        | 9         | 6         | 8            | <b>7</b> | 9        | 2       | 4                | က         | <b>7</b>     | -         | 0       |
| (M3, 8h)            | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0 P.Z     | 0            | 0 0       | 0       |
| T2V2                | T2V2.15  | T2V2.14   | T2V2.13   | T2V2.12   | T2V2.11  | T2V2.10   | T2V2.9    | T2V2.8       | T2V2.7   | T2V2.6   | T2V2.5  | T2V2.4           | T2V2.3    | T2V2.2       | T2V2.1    | T2V2.0  |
| (M3, 9h)            | 0        | 0         |           | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| T2R2                | T2R2.15  | T2R2.14   | T2R2.13   | T2R2.12   | T2R2.11  | T2R2.10   | T2R2.9    | T2R2.8       | T2R2.7   | T2R2.6   | T2R2.5  | T2R2.4           | T2R2.3    | T2R2.2       | T2R2.1    | T2R2.0  |
| (INIS, AII)<br>T2C2 | T2C:2 15 | T2C:2 14  | T2C:2 13  | T2C:2 12  | T2C:2 11 | T2C.2 10  | T2C:2 9   | T2C.2 8      | T2C27    | 120.2 6  | T2C25   | T2C:24           | T2C23     | T2C2 2       | T2C2 1    | T2C20   |
| (M3, Dh)            | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0.505   |
| T2CFG2              |          | 1         |           |           |          | -         |           | 1            |          | T2DIV2   | T2DIV1  | T2DIV0           | T2MD      | CCF1         | CCF0      | C/T2    |
| (M3, 10h)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| 000                 | I        | I         |           |           | ı        | I         |           | I            | ERIE     | STIE     | PDE     | SIESTA           | CRST      | AUTOB        | ERCS      | SWINT   |
| (M4, 0h)            | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | - (i      | 0 [          | 0         | - 6     |
| COS                 |          | 0         | 0         | 0         |          | 0         | 0         | 0            | BSS      | EC96/128 | WKS     | HXS              | SXI       | ER2          | ER1       | ERO     |
| (IM4, ITI)          | 0        | >         | >         | >         | 0        | >         | >         | 0            | O INTINI | OUL      | UNTINE  | ONITINI          | O INTINIS | OUTINI       | O INITINI | ONITIN  |
| (M4. 2h)            | 0        | 0         | 0         | 0         | 0        | 0         | 0         | О            | 0        | 0        | C C     | 0                | 0         | 0            | 0         |         |
| COTE                | ·        | )         | ·         | )         | )        | ·         | ·         | )            | C0TE.7   | COTE.6   | COTE.5  | COTE.4           | COTE.3    | COTE.2       | COTE.1    | COTE.0  |
| (M4, 3h)            | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| CORE                |          | 1         | 1         | 1         |          | 1         | 1         | ı            | C0RE.7   | CORE.6   | CORE.5  | CORE.4           | C0RE.3    | C0RE.2       | C0RE.1    | C0RE.0  |
| (M4, 4h)            | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| COR                 |          | I         |           | I         |          | I         | 1         | 1            | CANOBA   | INCDEC   | AID     | C0BPR7           | COBPR6    | I            | COBIE     | COIE    |
| (M4, 5h)            | 0        | 0         |           | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| CODP                | C0DP.15  | C0DP.14   | C0DP.13   | C0DP.12   | C0DP.11  | C0DP.10   | CODP.9    | CODP.8       | C0DP.7   | CODP.6   | CODP.5  | CODP.4           | CODP.3    | CODP.2       | C0DP.1    | C0DP.0  |
| (M4, 6N)            | 0 0      | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0 0      | 0        | 0 0     | 0 0              | 0 000     | 0 0          | 0         | 0       |
| (MA 7b)             | CUUD. 13 | C000B. 14 | COUDS. 13 | CUDB. 12  | CUDB.    | COUDE. 10 | CODE.9    | OUDD:0       | CODB./   | COUDE.0  | CODD:   | 0000<br>4.0000.4 | COUDB.3   | COUDB.Z      | COUDE.    | CODB.U  |
| CORMS               | >        | CORMS, 15 | CORMS, 14 | CORMS, 13 | CORMS.12 | CORMS.11  | CORMS, 10 | CORMS.9      | CORMS.8  | CORMS.7  | CORMS.6 | CORMS.5          | CORMS.4   | CORMS.3      | CORMS.2   | CORMS.1 |
| (M4, 8h)            | 0        | 0         |           |           | 0        | _         | 0         |              | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| COTMA               |          | COTMA.15  | COTMA.14  | COTI      | COTMA.12 | COT       | COTMA.10  | COT          | COTMA.8  | COTMA.7  | COTMA.6 | COTMA.5          | COTMA.4   | COTMA.3      | COTMA.2   | COTMA.1 |
| (M4, 9n)            | 0        | О         | Э         | О         | 0        | Э         | 0         | Э            | 0        | o E      | 0 [     | 0                | 0         | 0            | 0         | 0 5     |
| M4 11h)             | 0        | 0         | 0         |           |          |           | 0         | 0            | MSRUT    | = 0      | 딤       | 2                | EXING     | 2            |           |         |
| COM2C               | >        | >         | >         | >         | )        | >         | >         | P            | MSRDY    |          | EBI     | INTRO            | EXTRO     | MTRQ         | ROW/TIH   | DTUP    |
| (M4, 12h)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| COM3C               |          | 1         | 1         | 1         |          | 1         | 1         | I            | MSRDY    | ETI      | ERI     | INTRQ            | EXTRQ     | MTRQ         | ROW/TIH   | DTUP    |
| (M4, 13h)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| COM4C               |          | I         | 1         | I         |          | I         | 1         | I            | MSRDY    | Е        | ERI     | INTRO            | EXTRQ     | MTRQ         | ROW/TIH   | DTUP    |
| (M4, 14h)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0 [      | 0 [     | 0 !:             | 0 (1)     | 0            | 0         | 0 j     |
| COMBC               |          | 0         | 0         | 0         |          | 0         | 0         | 0            | MSRUY    | E        | 품       | N KC             | EXIRO     | MINC<br>MINC | HCW/IIH   | an o    |
| COMEC               | >        | >         | >         | >         | >        | >         | >         | >            | MSRDY    | - E      | O E     | INTRO            | FXTRO     | MTRO         | ROW/TIH   | OTI IP  |
| (M4, 16h)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| COM7C               |          | 1         | 1         | 1         |          | 1         | 1         | ı            | MSRDY    | ETI      | ERI     | INTRQ            | EXTRQ     | MTRQ         | ROW/TIH   | DTUP    |
| (M4, 17h)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| COMBC               |          | 0         | 0         | (         |          | (         | (         | 0            | MSRDY    | E        | ERI     | INTRO            | EXTRQ     | MTRQ         | ROW/TIH   | DTUP    |
| (M4, 18h)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0 [     | 0                | 0 (       | 0            | 0         | 0       |
| COM9C<br>(M2 19h)   | <        | <         | 0         | <         | 0        | <         | <         | 0            | MSRDY    |          | ERI     | NTRO             | EXTRO     | MTRQ         | ROW/TIH   | DTUP    |
| COM 10C             | >        | >         |           | >         | >        | >         | >         | o            | MSRDY    |          | EBI     | INTRO            | EXTRO     | MTRO         | ROW/TIH   | DTUP    |
| (M4, 1Ah)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| COM11C              | 1        | 1         |           | 1         | 1        | 1         | 1         |              | MSRDY    | EI       | ERI     | INTRO            | EXTRQ     | MTRQ         | ROW/TIH   | DTUP    |
| (M4, 1Bh)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0        | 0       | 0                | 0         | 0            | 0         | 0       |
| COM12C              |          | 1         | 1         |           |          | 1         | 1 -       | 1            | MSRDY    | EI       | ERI     | INTRO            | EXTRQ     | MTRQ         | ROW/TIH   | DTUP    |
| (M4, 1Ch)           | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | 0        | 0 [      | 0 [     | 0                | 0         | 0            | 0         | 0 5     |
| Com13C<br>(M4 10b)  | 0        | 0         | 0         | 0         | 0        | 0         | 0         | 0            | MSRDY    | = c      | H 0     | Z<br>Z           | EXIRO     | Z C          | HCW/IIH   | 4010    |
| (IVI4, 17.1)        | ٥        | ٥         | ٥         | 2         | ٥        | ٥         | ٥         | ٥            | 5        | ٥        | ٥       | ٥                | >         | o o          | o o       | ٥       |

42 \_\_\_\_\_\_**/V**|**/X**|**/V**|

# MAXQ7665A-MAXQ7665D

# 16-Bit RISC Microcontroller-Based **Smart Data-Acquisition Systems**

| aple        | 5. Peri | pheral | Regis  | ter Bii | able 5. Peripheral Register Bit Functions and Reset Values (continued | ionsa  | ind Ke | set Va       | ) sanır | contil                  | nued)    |         |       |   |
|-------------|---------|--------|--------|---------|---|--------|--------|--------------|---------|-------------------------|----------|---------|-------|---|
| REGISTER    |         |        |        |         |   |        |        | REGISTER BIT | BIT     |                         |          |         |       |   |
| 0           | 15      | 14     | 13     | 12      | 11  | 10     | 6      | 8            | 7       | 9                       | 2        | 4       | 3     |   |
| COM 145     | 1       | -      | 1      | 1       | 1   | 1      | 1      | _            | MSRDY   | ETI                     | ERI      | INTRO   | EXTRQ |   |
| (IM4, IEII) | 0       | 0      | 0      | 0       | 0   | 0      | 0      | 0            | 0       | 0                       | 0        | 0       | 0     |   |
| COM15C      | 1       | -      | 1      | 1       | 1   | 1      | 1      | _            | MSRDY   | ETI                     | ERI      | INTRO   | EXTRQ |   |
| (M4, 1Fh)   | 0       | 0      | 0      | 0       | 0   | 0      | 0      | 0            | 0       | 0                       | 0        | 0       | 0     |   |
| VMC         |         |        |        | _       | _   |        |        | _            | -       | -                       | VIOBI1   | VIOBIO  | VDB11 |   |
| (M5, 0h)    | 0       | 0      | 0      | 0       | 0   | 0      | 0      | 0            | 0       | 0                       | 0        | 0       | 0     |   |
| APE         | 1       |        | -      | VIBE    | VDBE  | VDPE   |        |              | PGG2    | PGG1                    | PGG0     | TSE     | PGAE  |   |
| (M5, 1h)    | 0       | 0      | 0      | 0       | 0   | -      | 0      | 0            | 0       | 0                       | 0        | 0       | 0     |   |
| ACNT        | ADCMX4  | ADCMX3 | ADCMX2 | ADCMX1  | ADCMX0  | ADCDIF | ADCBIP | _            | -       | ADCDUL                  | _        | ADCASD  | ADCBY | ′ |
| (M5, 2h)    | 0       | 0      | 0      | 0       | 0   | 0      | 0      | 0            | 0       | 0                       | 0        | 0       | 0     |   |
| TIVUU       | ı       | I      |        | ı       | ı   |        | ı      |              | I       | DACI DACI DACI SOLIDACI | 10 IO IO | חם וטעם | ı     |   |

Bits indicated by "---" are unused.

AIE (M5, Ah)

DACO (M5, 6h)

ADCD (M5, 8h) TSO (M5, 9h)

ASR (M5, Bh) OSCC (M5, Ch)

Bits indicated by "ST" reflect the input signal state.

Bits indicated by "DB" have read/write access only in background or debug mode. These bits are cleared after a POR. Bits indicated by "S" are only affected by a POR and not by other forms of reset. These bits are set to 0 after a POR.

Bits indicated by "DW" are only written to in debug mode. These bits are cleared after a POR.

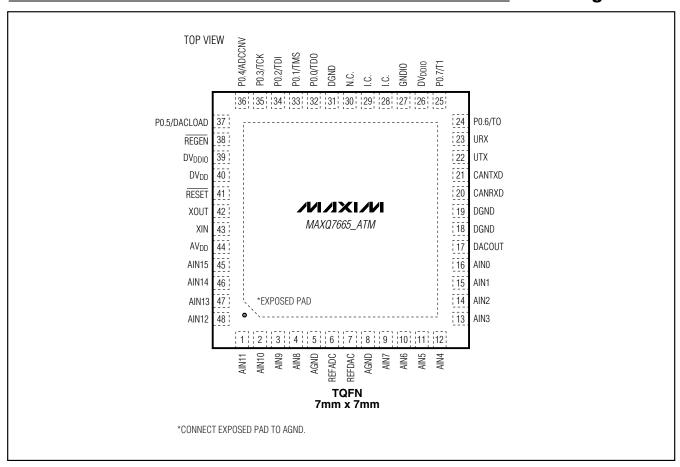
The OSCC register is cleared to 0002h after a POR and is not affected by other forms of reset

### 

## **Typical Operating Circuit** 2N3904 TEMPERATURE SENSOR DUAL-BRIDGE SENSOR DUAL-BRIDGE SENSOR LIN**TRANSCEIVER** MIXIM MAXQ7665A-MAXQ7665D MIXXIM MAX13050 CANH CANTXD CAN TRANSCEIVER CAN 2.0B MAXQ20 /VI/IXI/VI 16-BIT RISC MICRO MAX5024 SET LD0 128KB FLASH EXTERNAL RESET IS OPTIONAL RESET 512 BYTES DATA RAM GNDIO AGND XOUT

44 \_\_\_\_\_\_**/V|/X|/V|** 

### Pin Configuration



### **Chip Information**

PROCESS: BiCMOS and CMOS

### **Ordering Information/Selector Guide**

| PART            | PIN-PACKAGE | PKG CODE  | FLASH SIZE (KB)   |
|-----------------|-------------|-----------|-------------------|
| MAXQ7665AATM+** | 48 TQFN-EP* | T4877MK+6 | 128<br>(64K x 16) |
| MAXQ7665BATM+   | 48 TQFN-EP* | T4877MK+6 | 64<br>(32K x 16)  |
| MAXQ7665CATM+** | 48 TQFN-EP* | T4877MK+6 | 48<br>(24K x 16)  |
| MAXQ7665DATM+** | 48 TQFN-EP* | T4877MK+6 | 32<br>(16K x 16)  |

<sup>+</sup>Devices are only available in lead-free packaging.

Note: All devices are specified for operation over the -40°C to +125°C automotive temperature range.

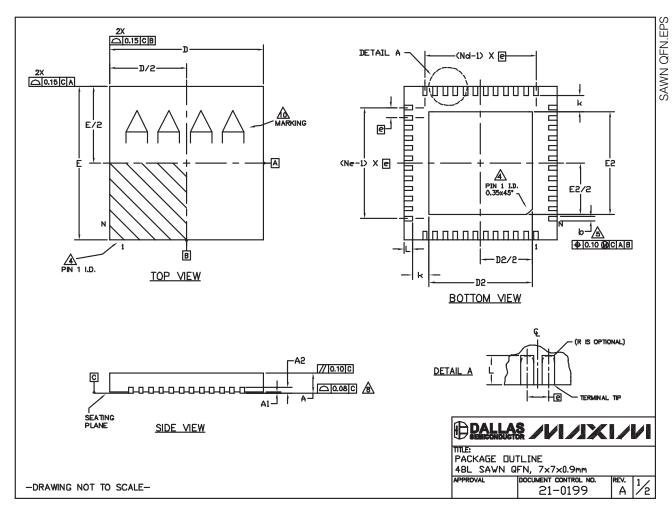
\_/N/XI/N

<sup>\*</sup>EP = Exposed pad.

<sup>\*\*</sup>Future Product—contact factory for availability.

### Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)

### NOTES

- 1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 3. N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESU 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
- $\underline{\triangle}$  DIMENSION 6 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25mm AND 0.30mm FROM TERMINAL TIP.
- 6. No AND No REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- 7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- & COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- 9. WARPAGE SHALL NOT EXCEED 0.10mm.
- 10 MARKING IS FOR PACKAGE DRIENTATION REFERENCE ONLY.
- 11. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.

|        | DIMEN:         | SIOIS    |      |  |  |  |
|--------|----------------|----------|------|--|--|--|
| SYMBOL | MIN.           | NDM.     | MAX. |  |  |  |
| Α      | 0.80           | 0.85     | 0.90 |  |  |  |
| A1     | 0              | 0.02     | 0.05 |  |  |  |
| A2     |                | 0.20 REF |      |  |  |  |
| lo     | 0.20           | 0.25     | 0.30 |  |  |  |
| D      | 6.90           | 7.00     | 7.10 |  |  |  |
| Ε      | 6.90           | 7.00     | 7.10 |  |  |  |
| D2     | 5.40           | 5.50     | 5,60 |  |  |  |
| E2     | 5,40           | 5.50     | 5.60 |  |  |  |
| е      | (              | 0.50 BSC | ),   |  |  |  |
| k      | 0.25           |          |      |  |  |  |
| L      | 0.30 0.40 0.50 |          |      |  |  |  |
| L1     | ı              | ı        | -    |  |  |  |
| N      |                | 48       |      |  |  |  |
| Nol    |                | 12       |      |  |  |  |
| Ne     |                | 12       |      |  |  |  |
| Pkg. C | odei 1         | 4877MK   | -6   |  |  |  |

PACKAGE DUTLINE

-DRAWING NOT TO SCALE-

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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